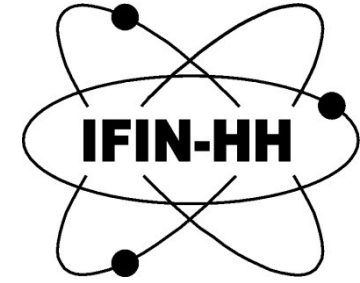


The logo for FAIR (Facility for Antiproton and Ion Research) features the word "FAIR" in a bold, black, sans-serif font. The letter "A" is stylized with a yellow arc above it, suggesting a particle path.

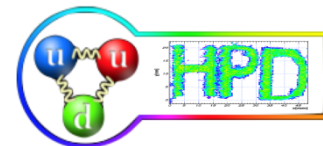
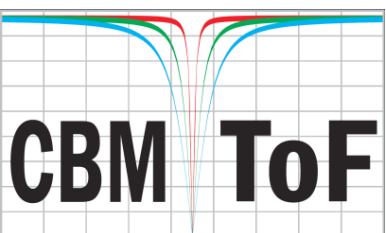
MINISTERUL CERCETĂRII ȘI INOVĂRII

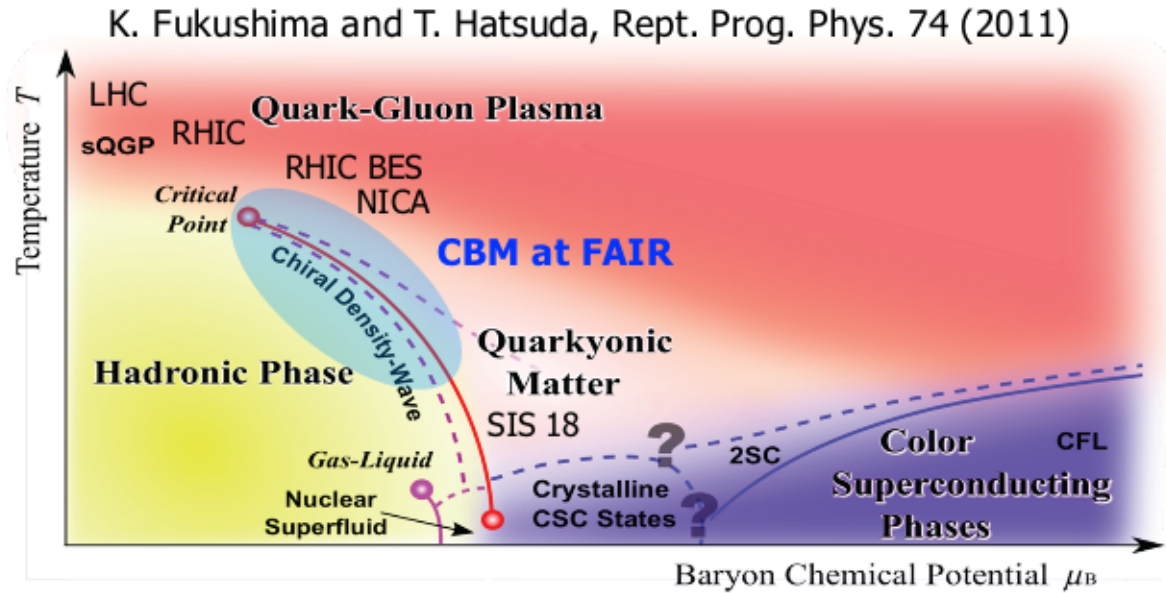


Proiect NUCLEU PN 19 06 01 03

Raport de etapa nr. 4

Proiectarea și realizarea a doua prototipuri de MSMGRPC, simulări APLAC ale impedanței liniei de transmisie, proiectarea zonei interne a subdetectorului de timp de zbor al CBM bazat pe detaliile constructive ale acestora (partea II)





CBM aims to investigate strongly interacting matter $\sqrt{6}$ in the region of high net baryon densities.

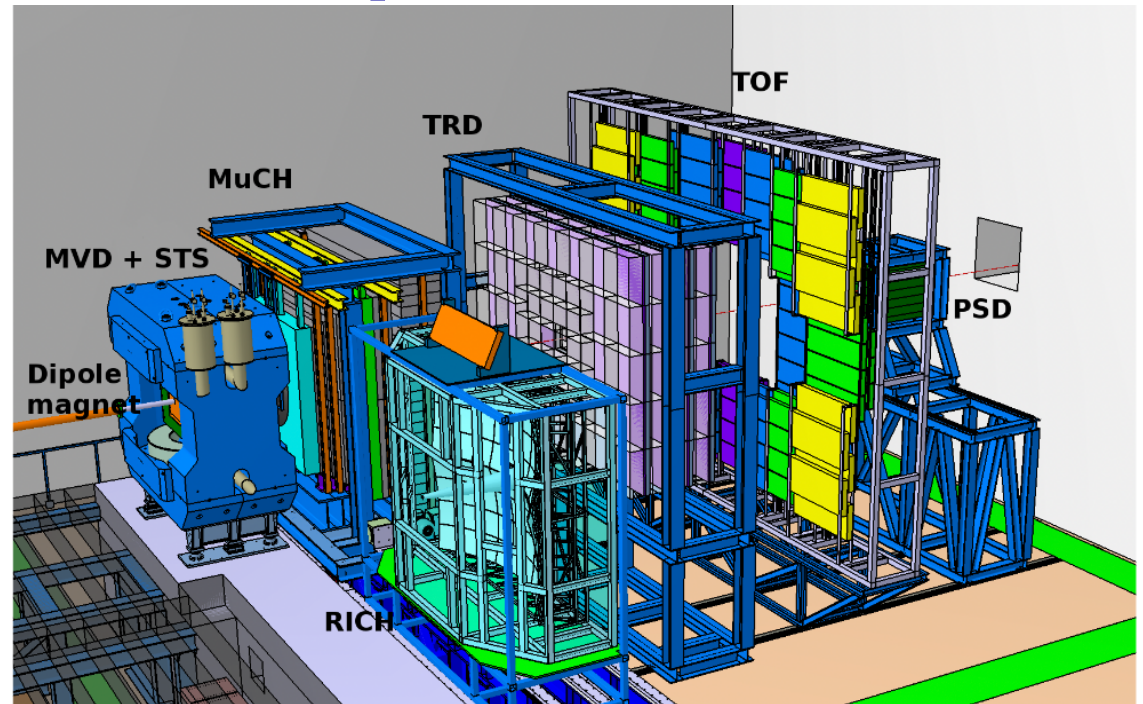
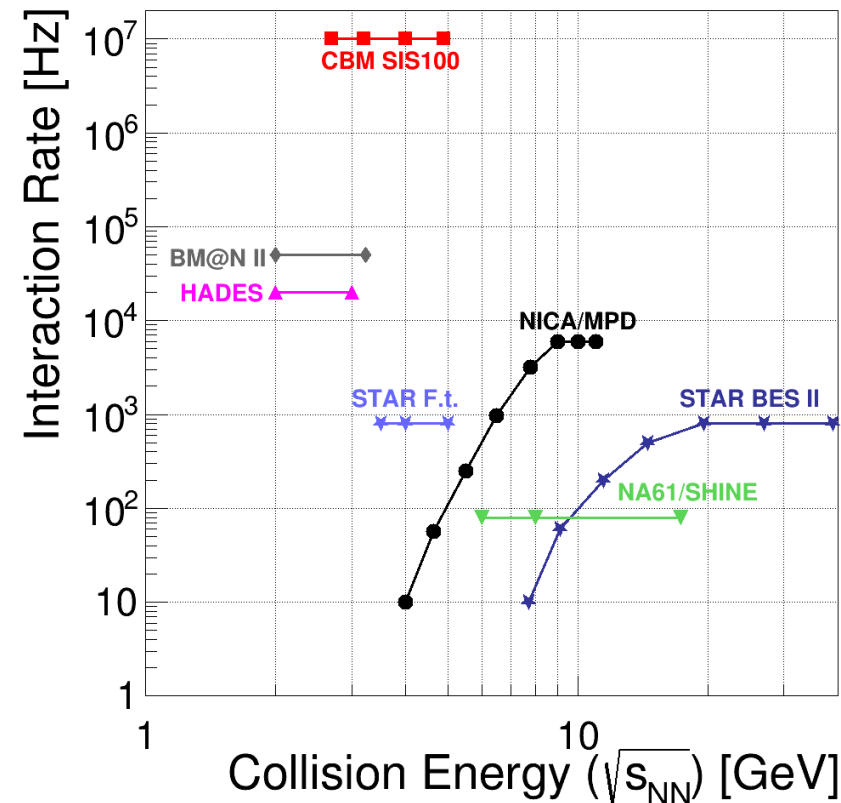
Investigation of:

- equation of state at high baryonic densities (neutron star core densities)
- hadronic – partonic phase transition and its type
- possible critical point predicted by QCD

SIS100 Beam	Plab, max	$\sqrt{(s_{NN,max})}$
Heavy ions (Au)	11A GeV	4.7 GeV
Light ions (Z/A=0.5)	14A GeV	5.3 GeV
protons	29 GeV	7.5 GeV

Experiments exploring dense QCD matter

CBM experiment @ SIS100/FAIR



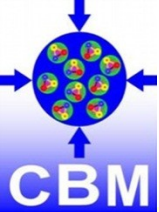
CBM will perform comprehensively high precision measurements of rarely produced observables. Multi-differential studies of rare probes (<1 particle per million events) require unprecedented statistics. Opens up new possibilities!

- ✓ Hadrons in dense baryonic matter and possible modification of their properties;
- ✓ Charm production at threshold beam energies and its properties in dense baryonic matter.

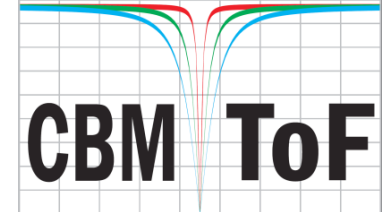
CBM: is a high rate experiment!

- Fast, radiation hard detectors and front-end electronics.
- Novel readout system:
 - **Free-streaming readout,**
 - detector hits with time stamps,
 - 4-D (space+time) event reconstruction.
- High speed data acquisition & performance computing farm for on-line event selection.

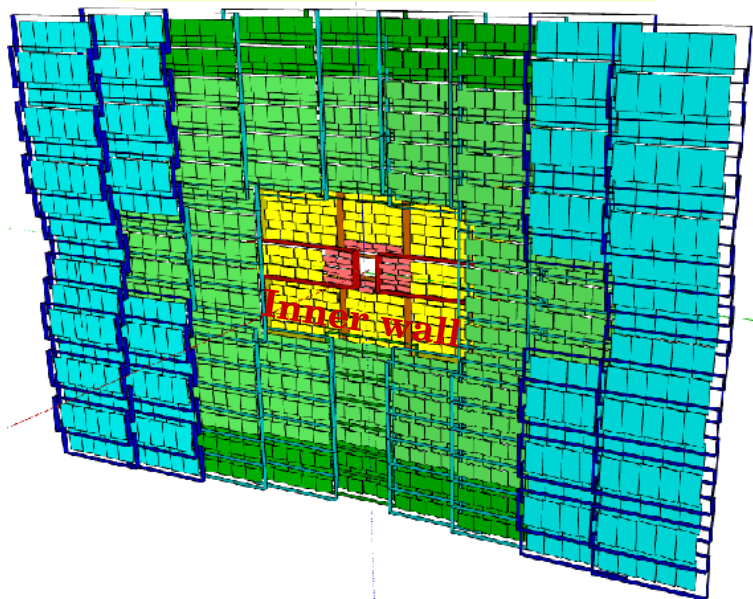
CBM Collaboration, *Eur. Phys. J. A* (2017) 53: 60



CBM – TOF requirements



CBM-TOF modular structure

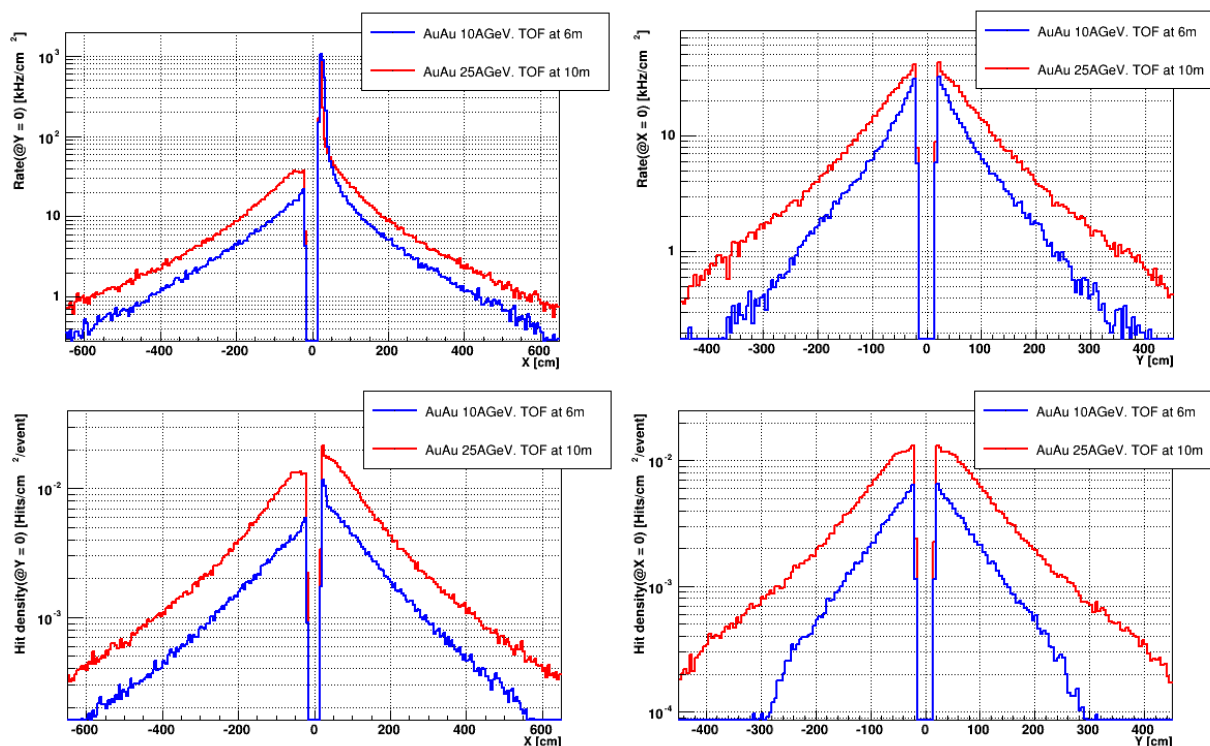


CBM-ToF Requirements:

- Full system time resolution $\sigma_T \sim 80$ ps
- Efficiency > 95%
- Rate capability ≤ 30 kHz/cm²
- Polar angular range 2.5° – 25°
- Active area of 120 m²
- Occupancy < 5%
- Low power electronics (~120.000 channels)
- **Free streaming data acquisition**

CBM Collaboration, "CBM – TOF Technical Design Report", October 2014

URQMD simulated charged particle flux from Au + Au events for an interaction rate of 10 MHz



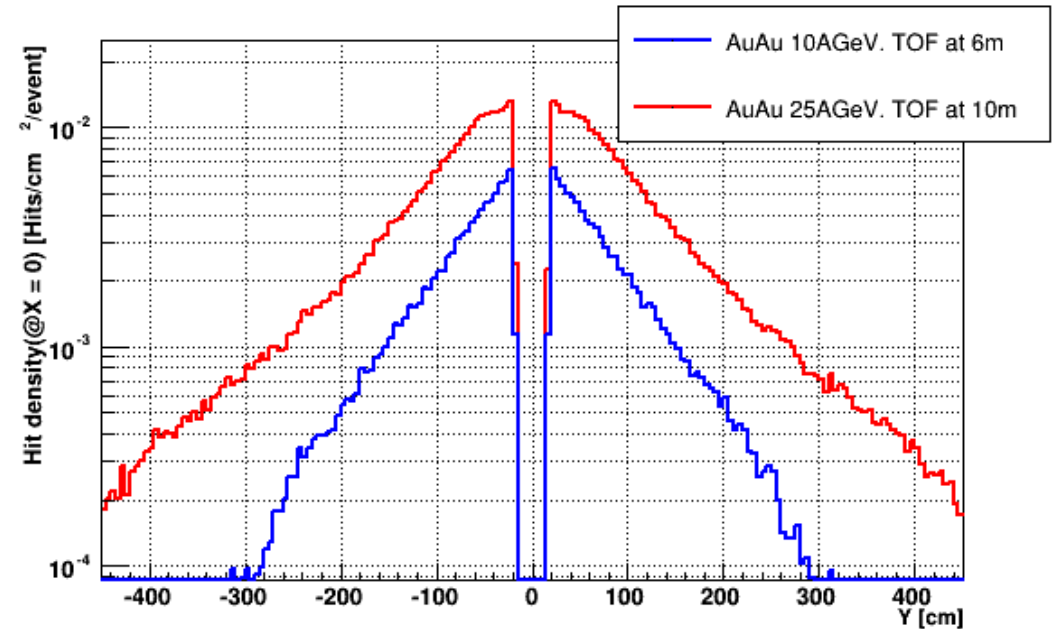
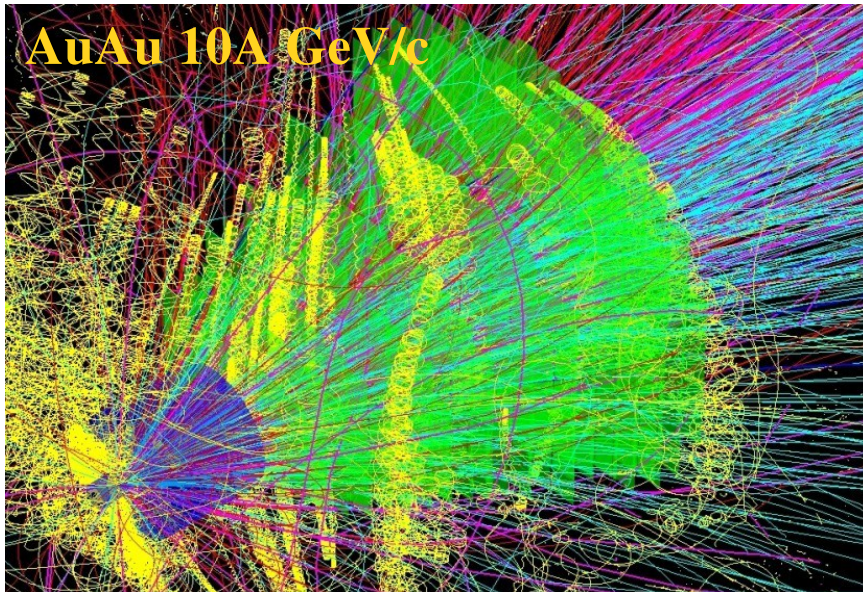
Detectors with different rate capabilities and granularities are needed as a function of polar angle

Our R&D activity addresses the CBM-TOF inner wall:

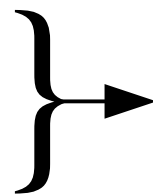
- highest counting rate
- highest granularity
- ~15 m² active area (2.5° – 12° polar angle)

Strip length calculation

for the highest granularity of the CBM-TOF wall



- occupancy = 5%
- maximum hit density = $0.6 \times 10^{-2} \text{ cm}^{-2}$
- strip pitch = 0.72 cm
- average cluster size = 1.8 strips



**6 cm strip length for the counter
with the highest granularity**

- **Calculule pentru o impedanta de 100 Ohm a liniei de transmisie a semnalului pentru 140 μm spatiu intre electrozii rezistivi folosind software-ul APLAC**

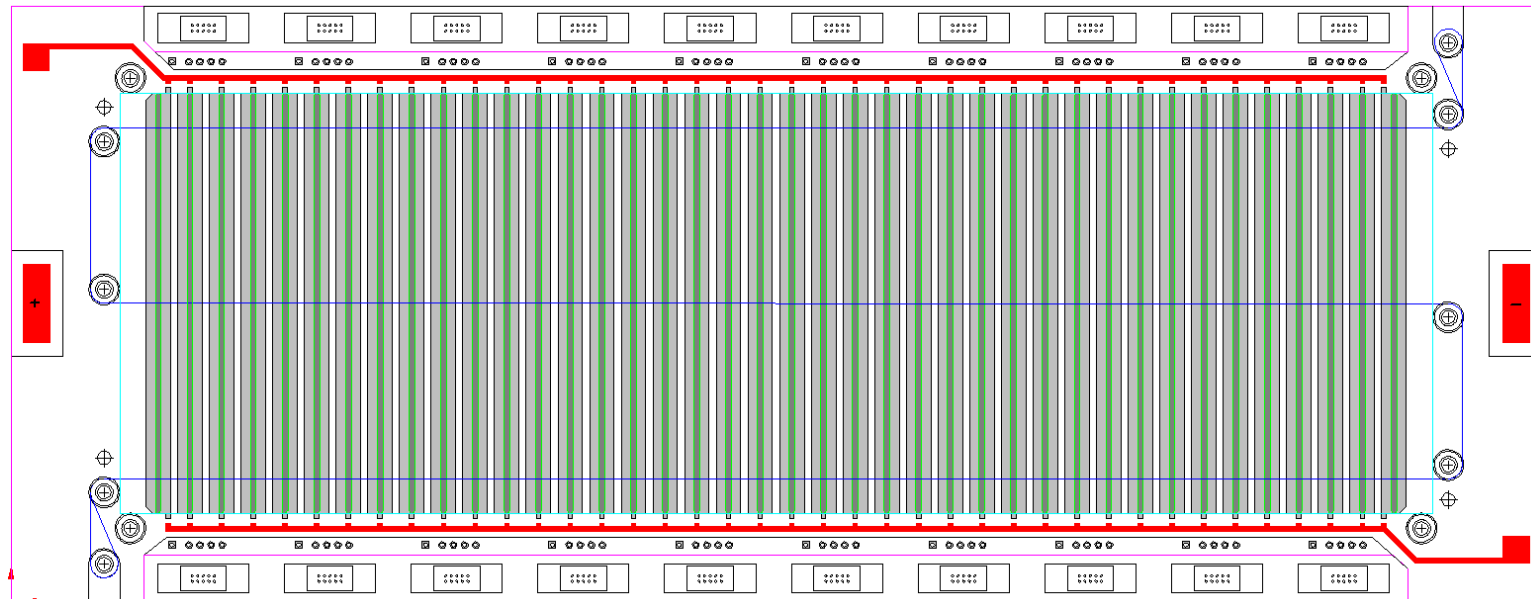
New RPC2018 prototype design

Motivation

RPC2015 prototypes:

- *SS. 10.1 mm strip pitch – 28 operated strips out of 28 – 100% active area*
 - *DS. 7.2 mm strip pitch – **32 operated strips out of 40** – 80% active area*
- ✓ *In order to fulfill the requirement to have modulo 32 readout strips compatible with 32 channels FEE baseboard*

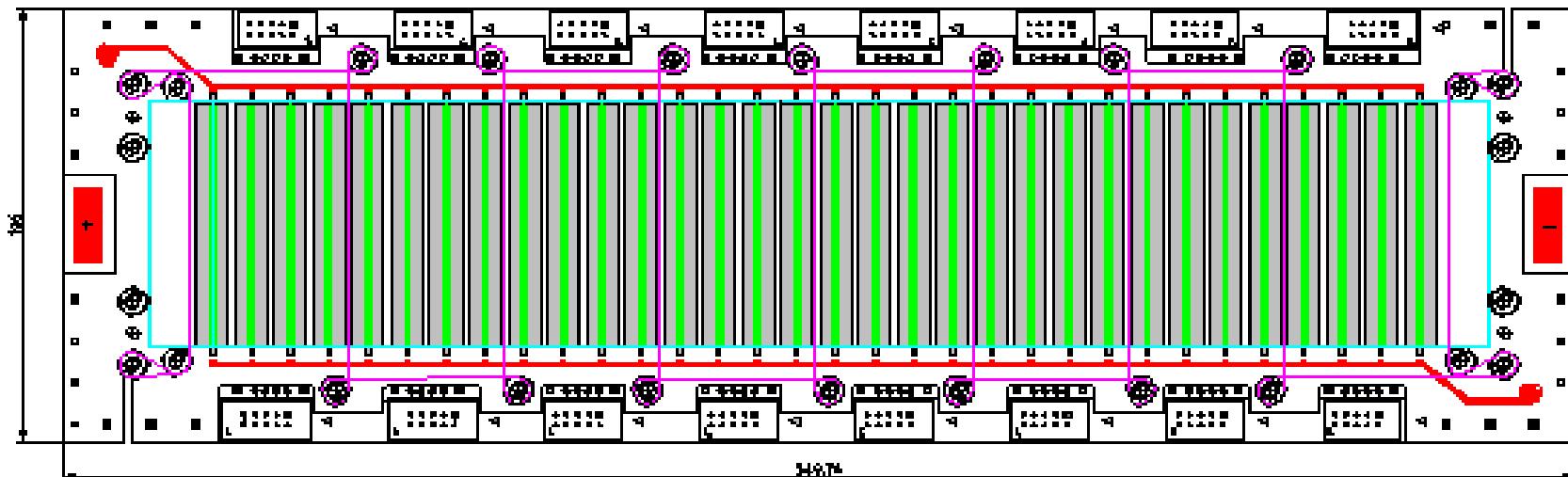
From RPC2015 to RPC2018 prototype



RPC2015

Readout electrode: 7.2 mm pitch= 1.3 mm width + 5.9 mm gap

High Voltage electrode: 7.2 mm pitch= 5.6 mm width + 1.6 mm gap



RPC2018

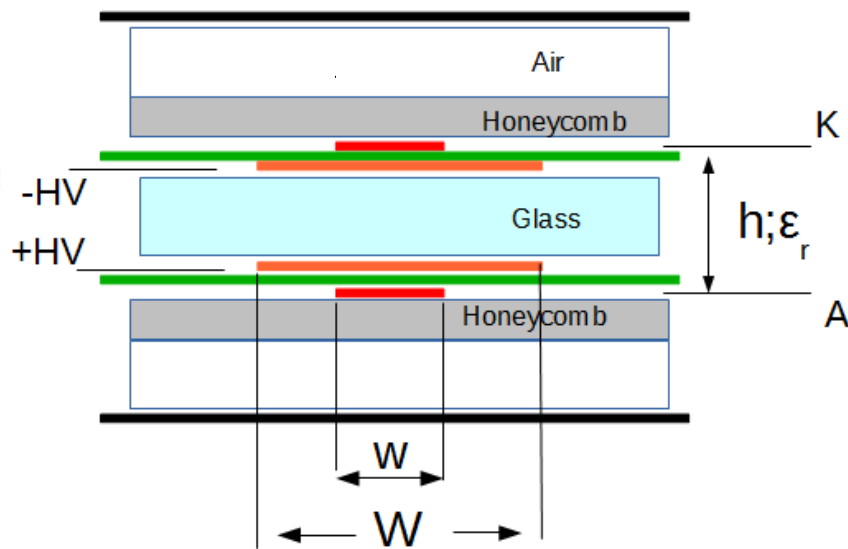
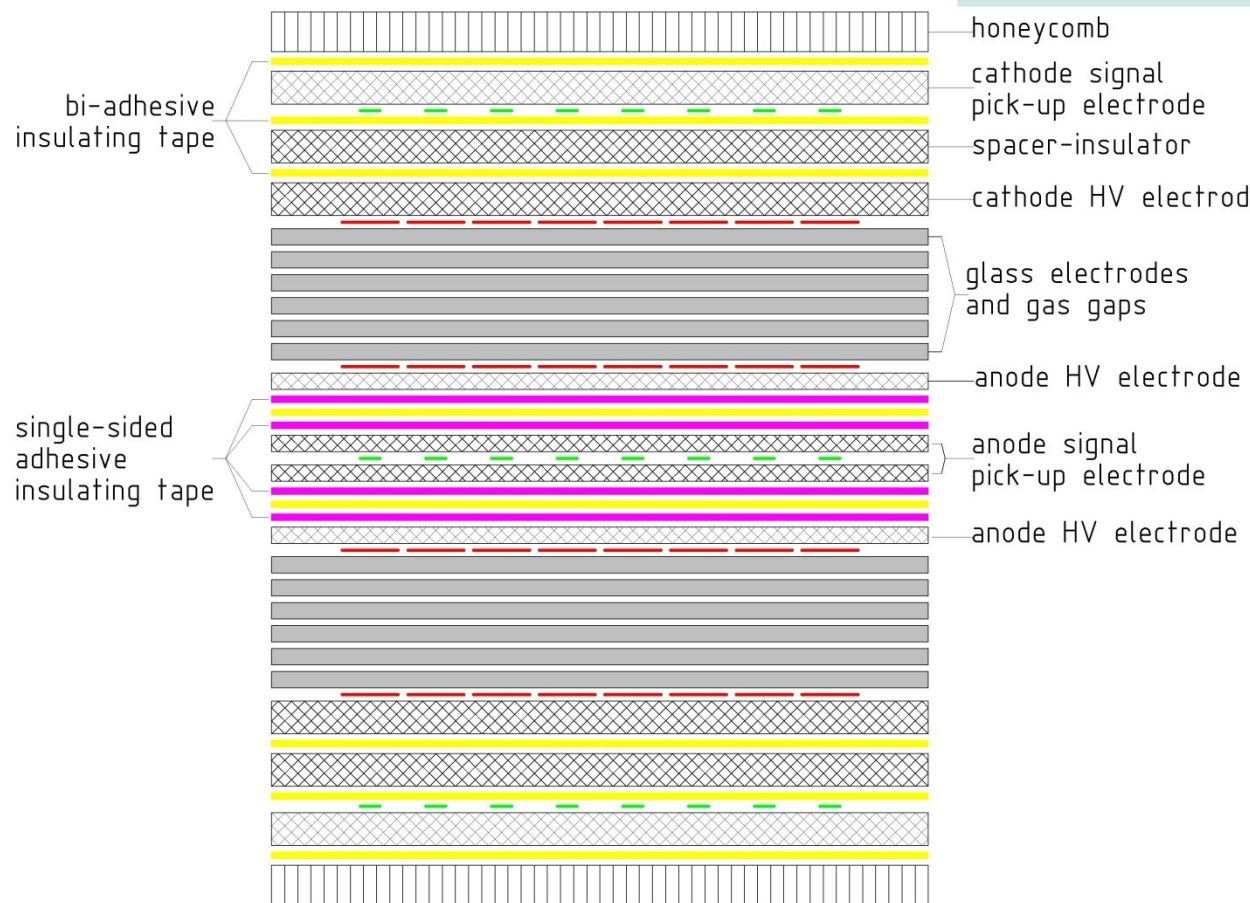
Readout electrode: 9.02 mm pitch= 1.27 mm width + 7.75 mm gap

High Voltage electrode: 9.02 mm pitch= 7.37 mm width + 1.65mm gap

Signal transmission line impedance in MSMGRPCs

Double stack, strip readout, multigap, timing RPC concept - MSMGRPC

- The overlapped readout strips and the materials in between define a signal transmission line (STL)
- STL impedance Z_0 depends on the readout strip width and the properties of the material layers in between
- APLAC software used for impedance estimations

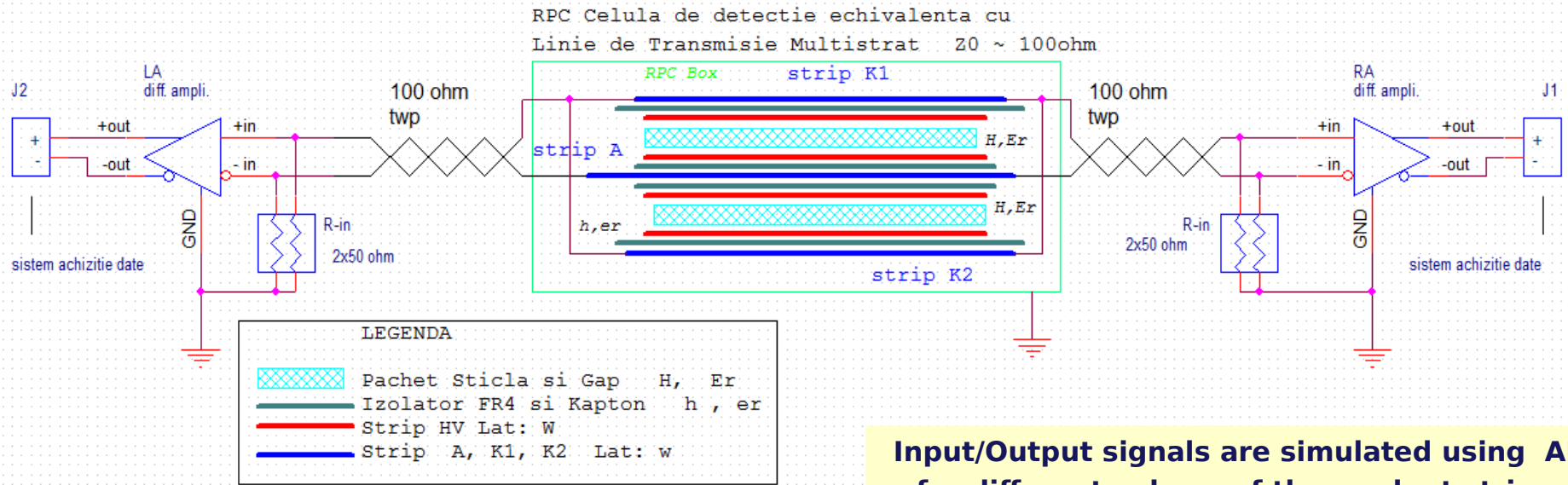


w = readout strip width
 W = high voltage strip width
 h = equivalent dielectric thickness
 ϵ = equivalent dielectric constant

**APLAC predicted $\sim 100 \Omega$ for
 1.27/7.4 mm readout/HV strip width**

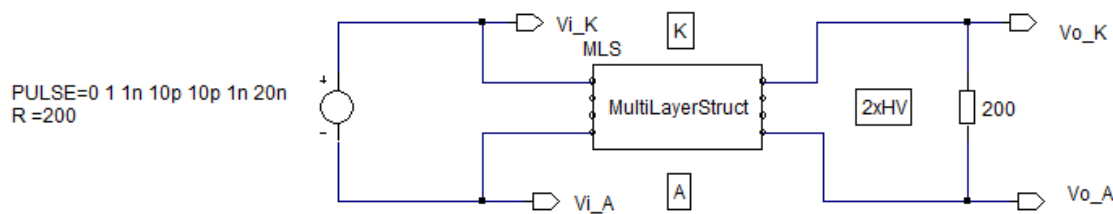
$$Z_0 = \sqrt{\frac{L'}{C'}}$$

APLAC simulations for the characteristic impedance of the MSMGRPC transmission line impedance

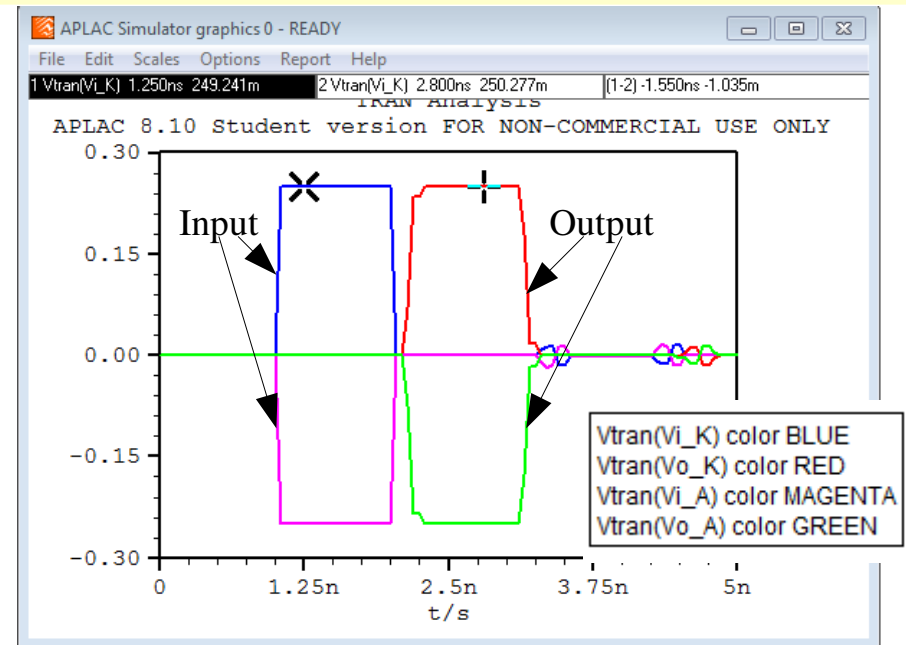


Input/Output signals are simulated using APLAC for different values of the readout strip width

Simulation scheme for one stack

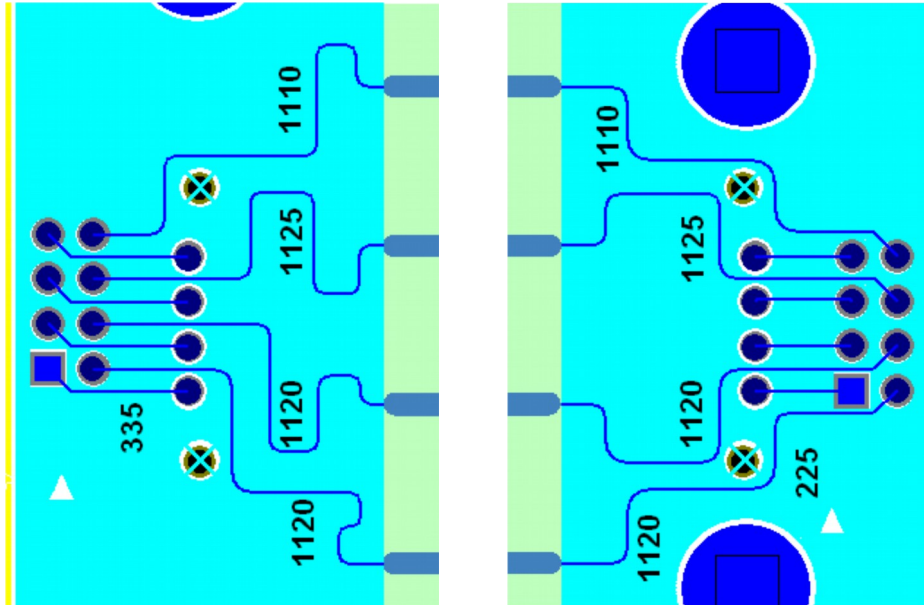


If $R = Z_0 = Z_L$ the transmission line is matched;
 Z_0 = characteristic impedance of a transmission line
 Z_L = load resistor connected to the transmission line
 R = internal resistance of the pulse generator

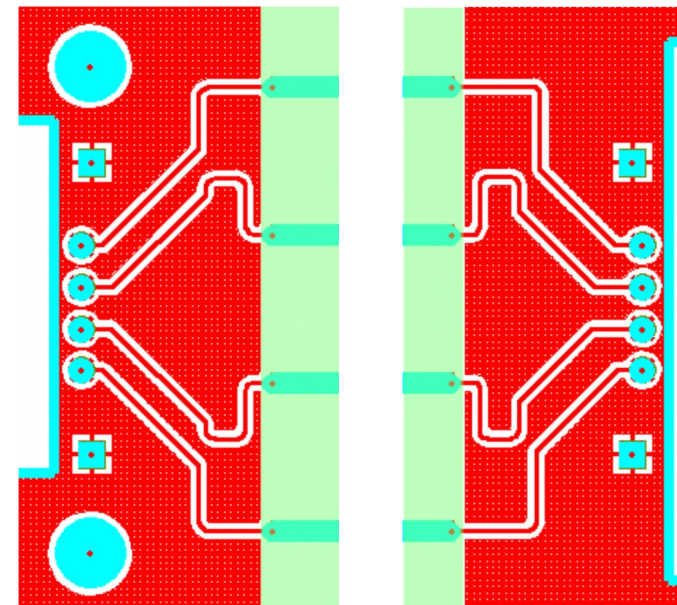


Calculations of the length of the traces for the transmission of the anode and cathode signals to the connectors

Anode board traces (50 Ω)



Cathode board traces (100 Ω)



AppCAD - [Stripline]

File Calculate Select Parameters Options Help

Stripline

Calculate Z0 [F4]

Z0 = 52.4 Ω

Elect Length = 0.182 λ

Elect Length = 65.4 de

1.0 Wavelength = 5503.108 mil

Vp = 0.466 frac

Dielectric: $\epsilon_r = 4.6$

FR-4

Frequency: 1 GHz

Length Units: mils

$\epsilon_{eff} = 4.60$

W/H = 0.333

AppCAD - [CPW]

File Calculate Select Parameters Options Help

Coplanar Waveguide

With Groundplane No Groundplane

Calculate Z0 [F4]

Z0 = 99.8 Ω

Elect Length = 0.129 λ

Elect Length = 46.5 de

1.0 Wavelength = 7743.738 mil

Vp = 0.656 frac

Dielectric: $\epsilon_r = 4.6$

FR-4

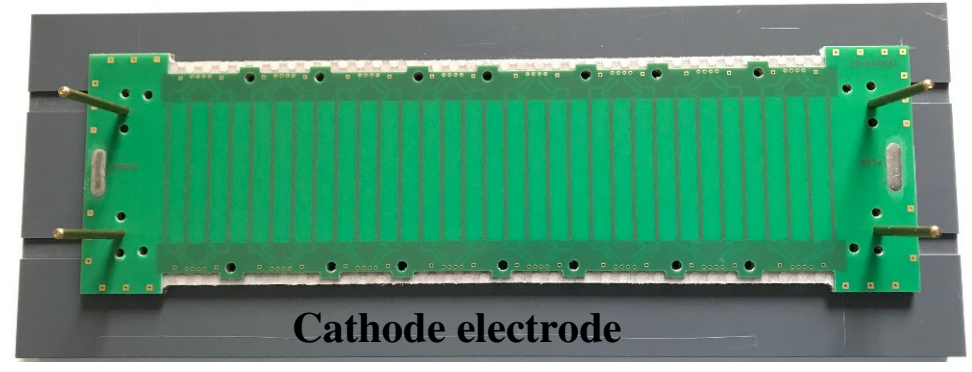
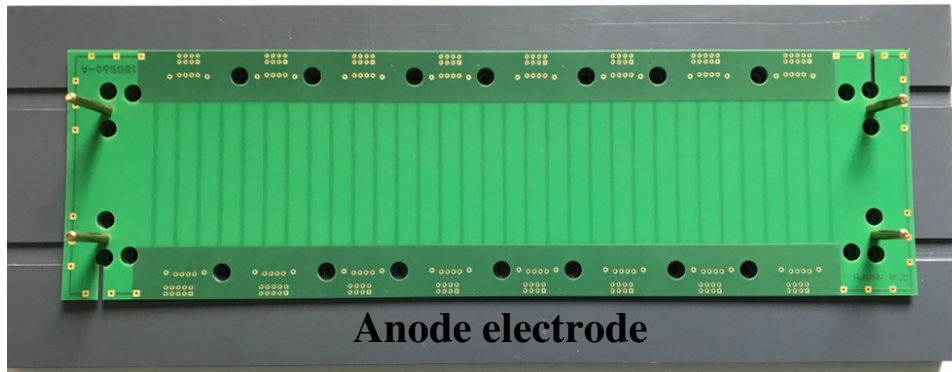
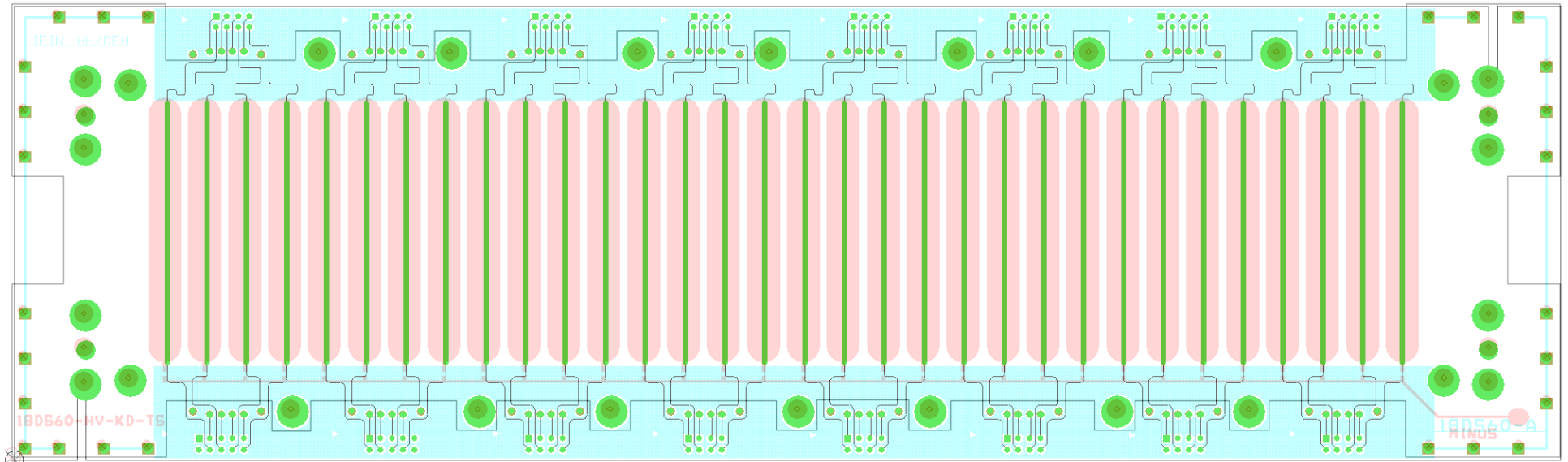
Frequency: 1 GHz

Length Units: mils

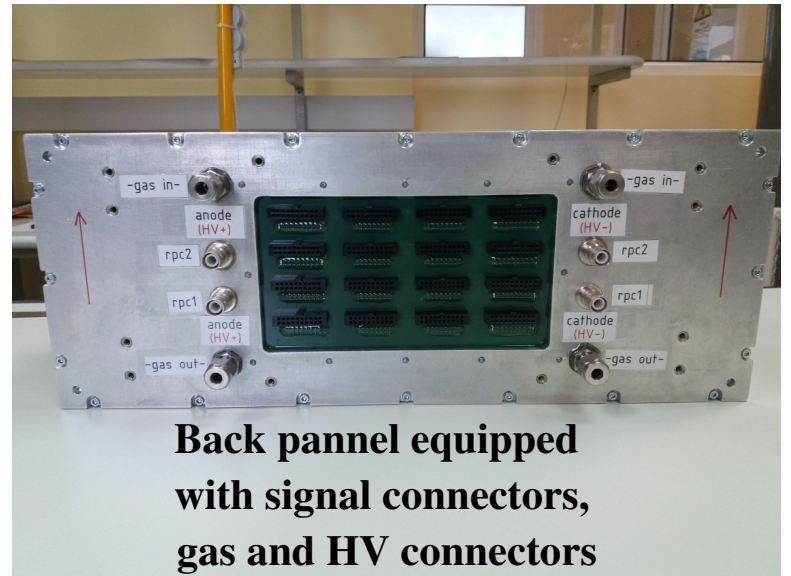
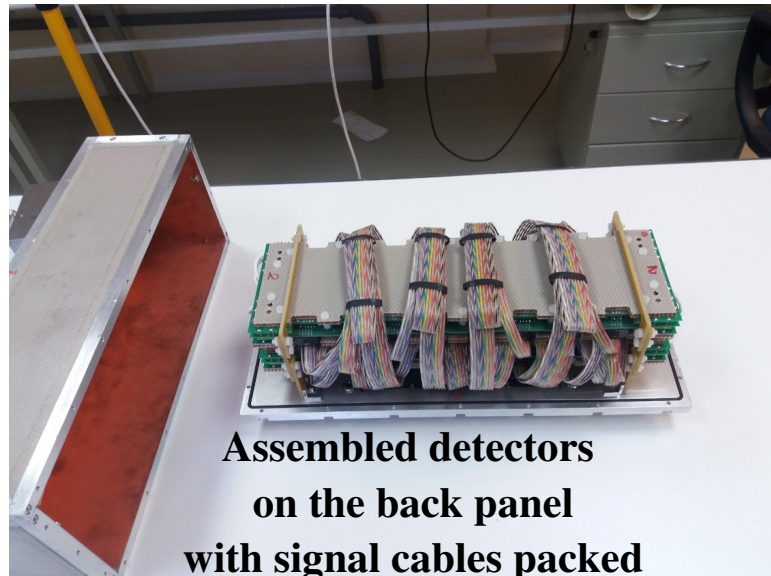
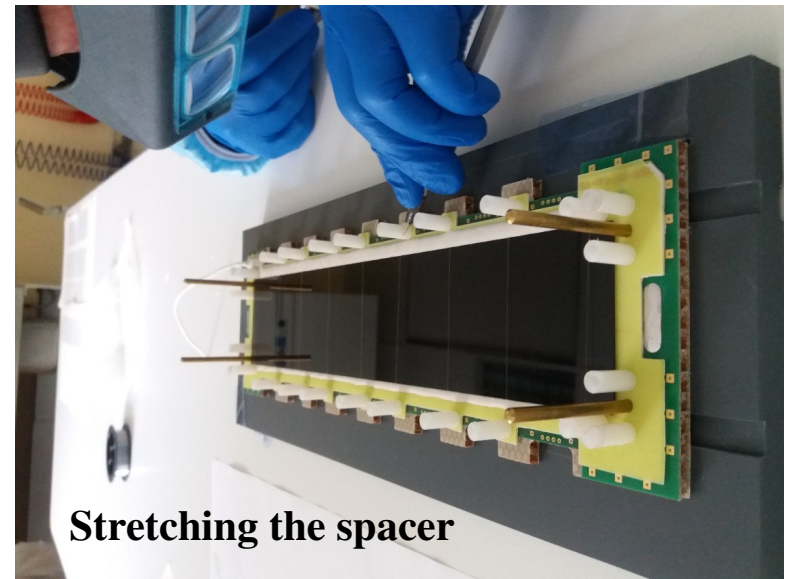
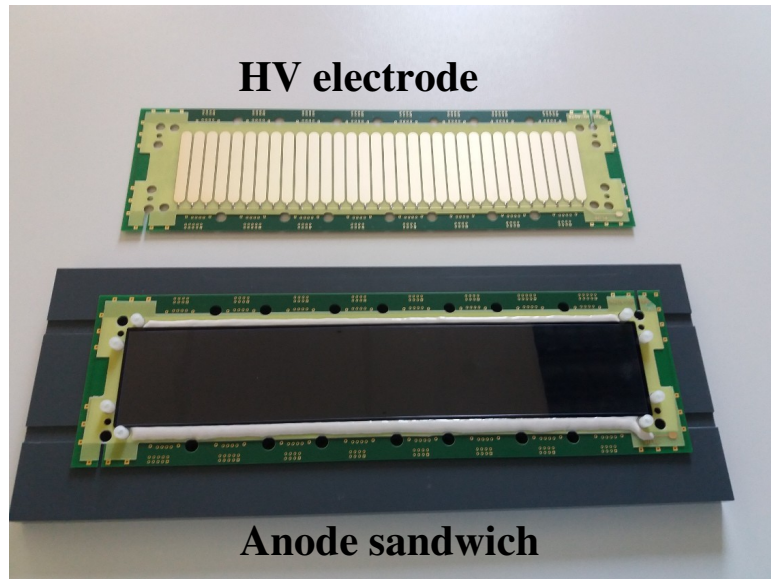
$\epsilon_{eff} = 2.32$

Shape factor = 0.211

OrCAD design of the readout electrodes and their manufacture

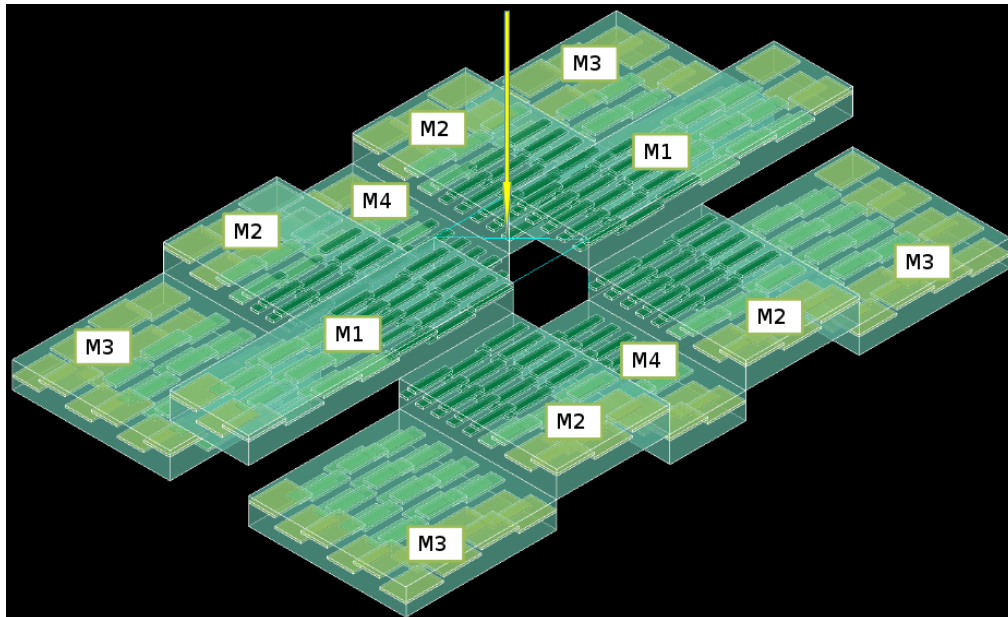


Prototype assembling



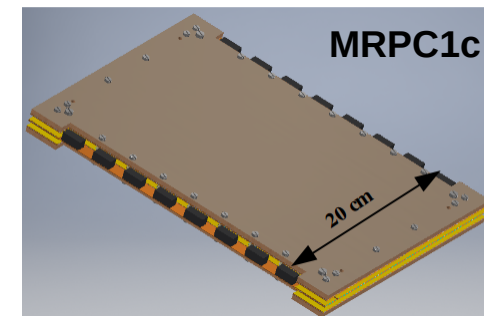
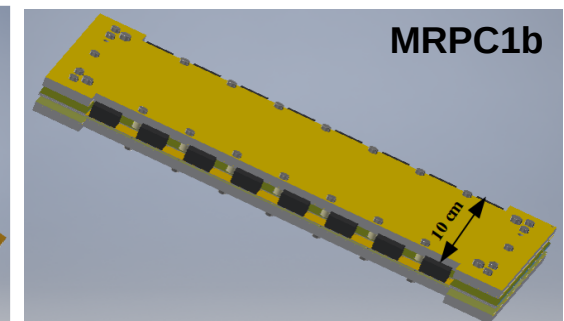
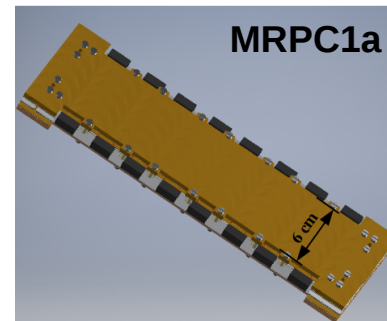
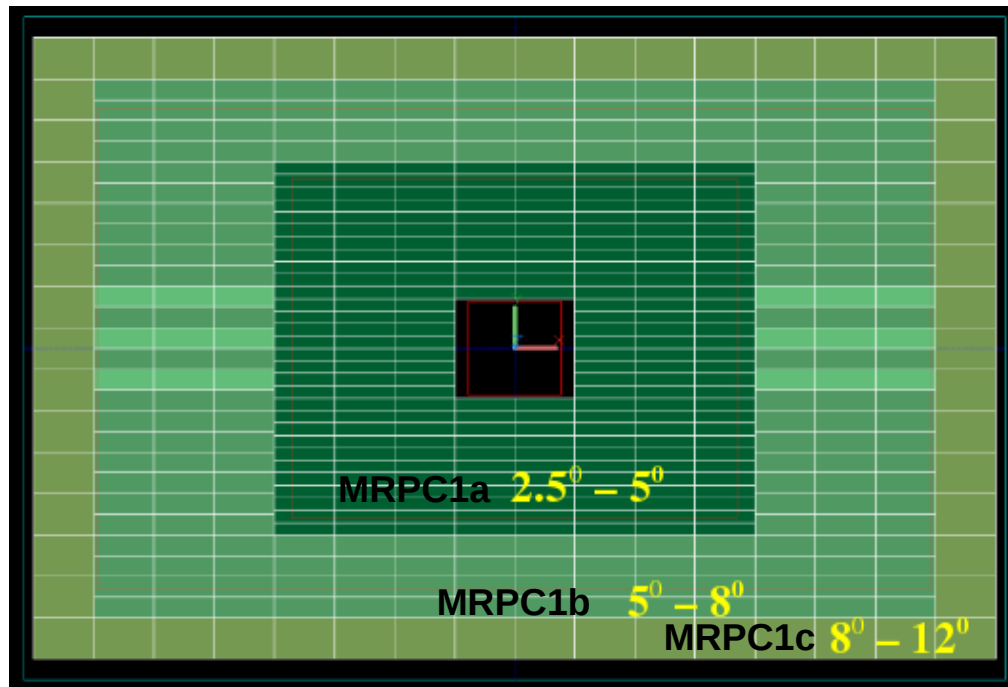
- **Desene de proiectare a zonei unghiurilor polare mici ale CBM-TOF bazat pe detaliile constructive ale acestor prototipuri, integrata constructiv in ansamblul subdetectorului CBM-TOF**

CBM-TOF Inner Wall Design



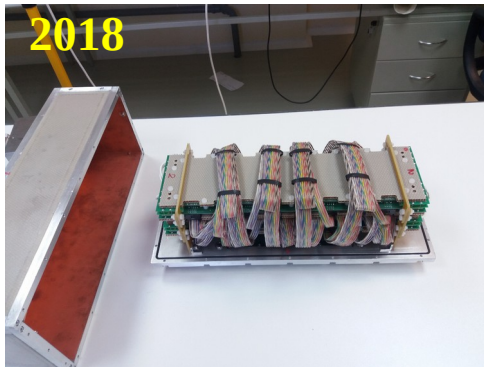
CBM-TOF inner zone – modular design

- $\sim 15 \text{ m}^2$ active area (4.7 m x 3.2 m)
- 12 modules of 4 types (2M1, 4M2, 4M3, 2M4)
- 470 MSMGRPCs of 0.9 mm strip pitch,
- 3 types of MSMGRPCs \rightarrow differ through the strip length :
 - 60 mm (MRPC1a) – 220 counters
 - 100 mm (MRPC1b) – 164 counters
 - 200 mm (MRPC1c) – 86 counters
- 30 080 readout channels

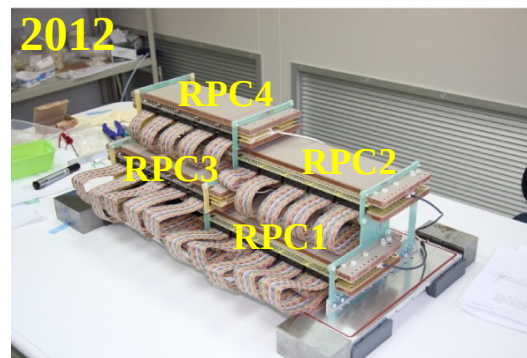


Prototypes for the CBM-TOF Inner Wall

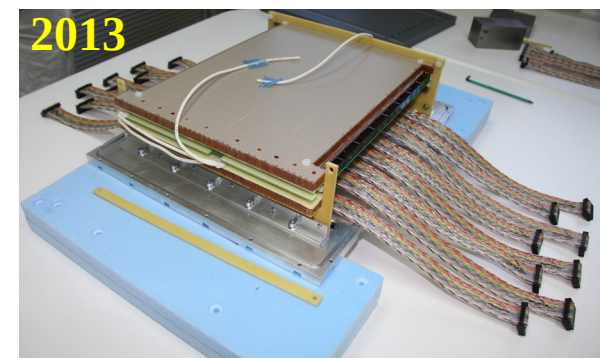
60 mm strip length



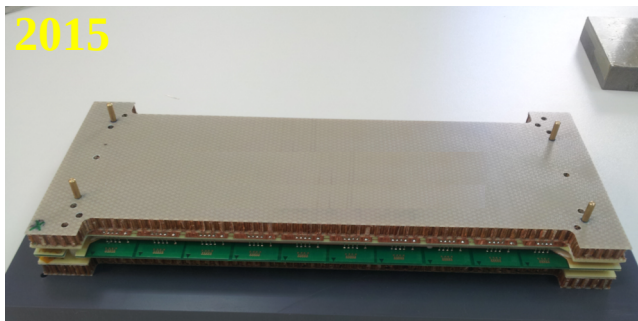
100 mm strip length



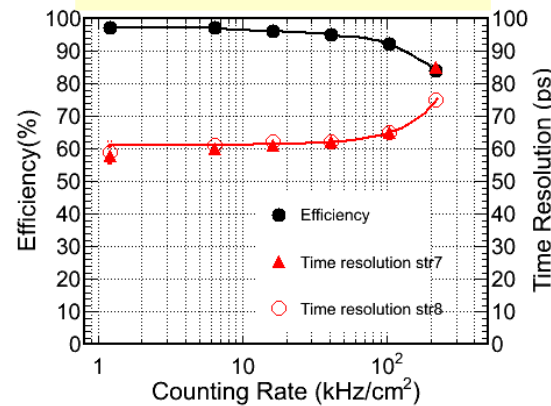
200 mm strip length



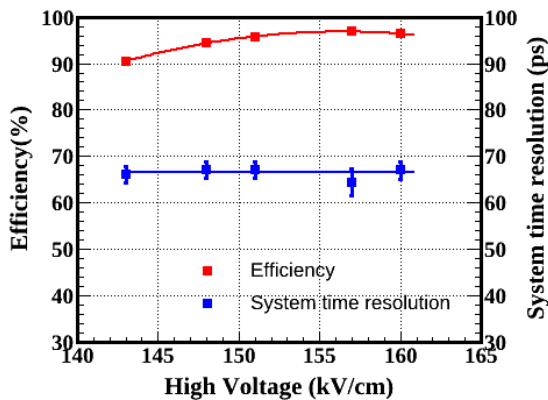
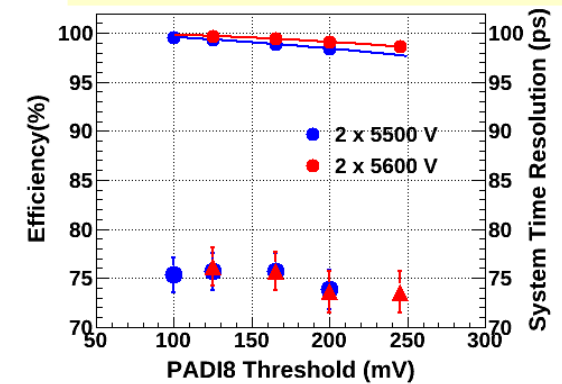
100 mm strip length



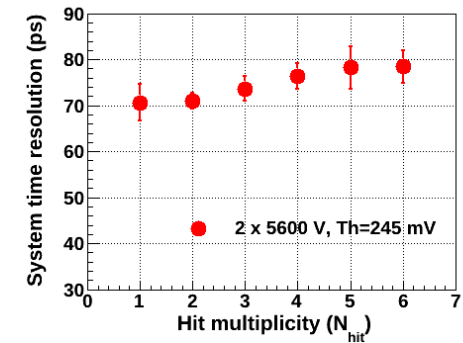
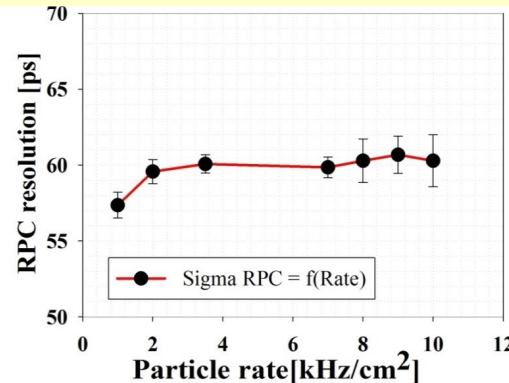
Focused p beam, 2.5 GeV/c @ COSY Jülich



1.1 GeV/u ¹⁵²Sm beam on Pb target GSI Darmstadt



Ni 1.9 GeV/u on Pb target GSI Darmstadt, exposure over whole active area

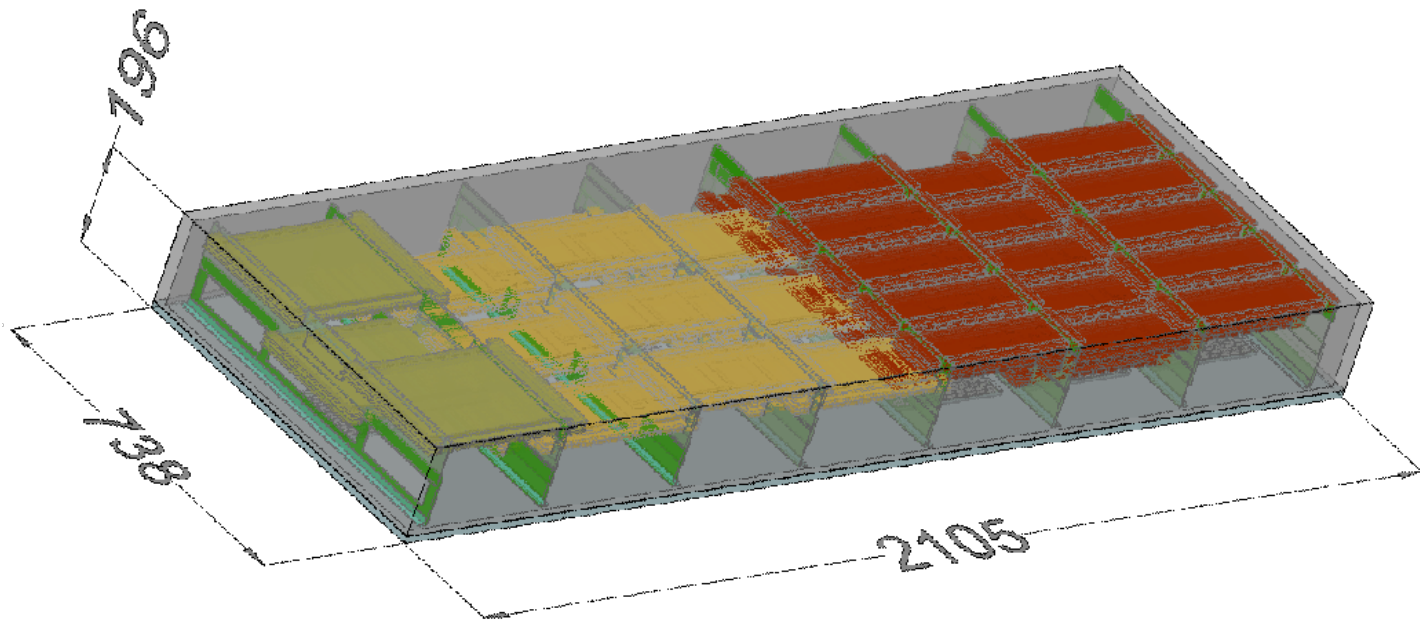


M. Petrovici et al. JINST 7 P11003, 2012

M. Petris et al. JINST 11 C09009, 2016

M. Petris et al., NIMA 920 (2019), 100

Modul M1 Design



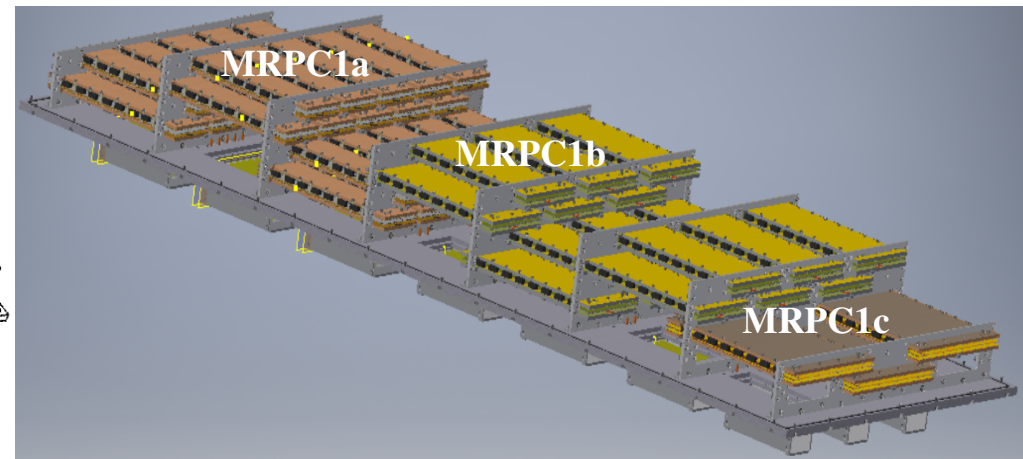
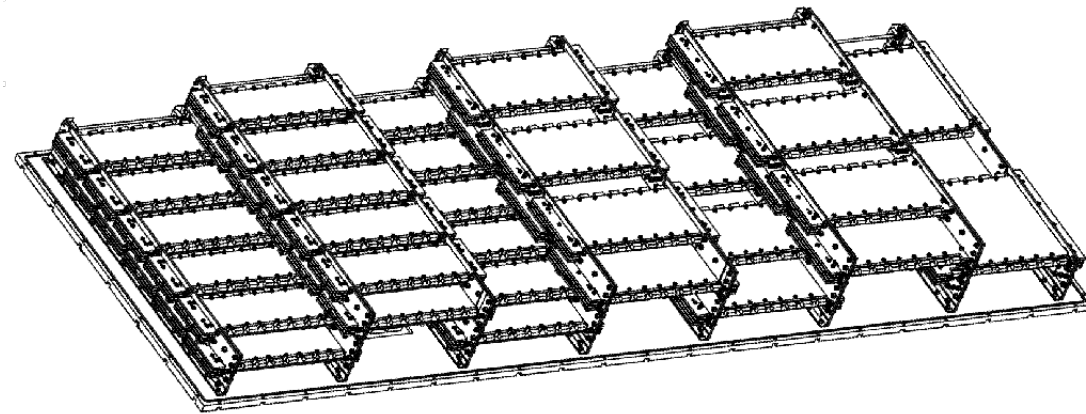
51 MSMGRPCs

- 30 x MRPC1a (60 mm)
- 18 x MRPC1b (100 mm)
- 3 x MRPC1c (200 mm)

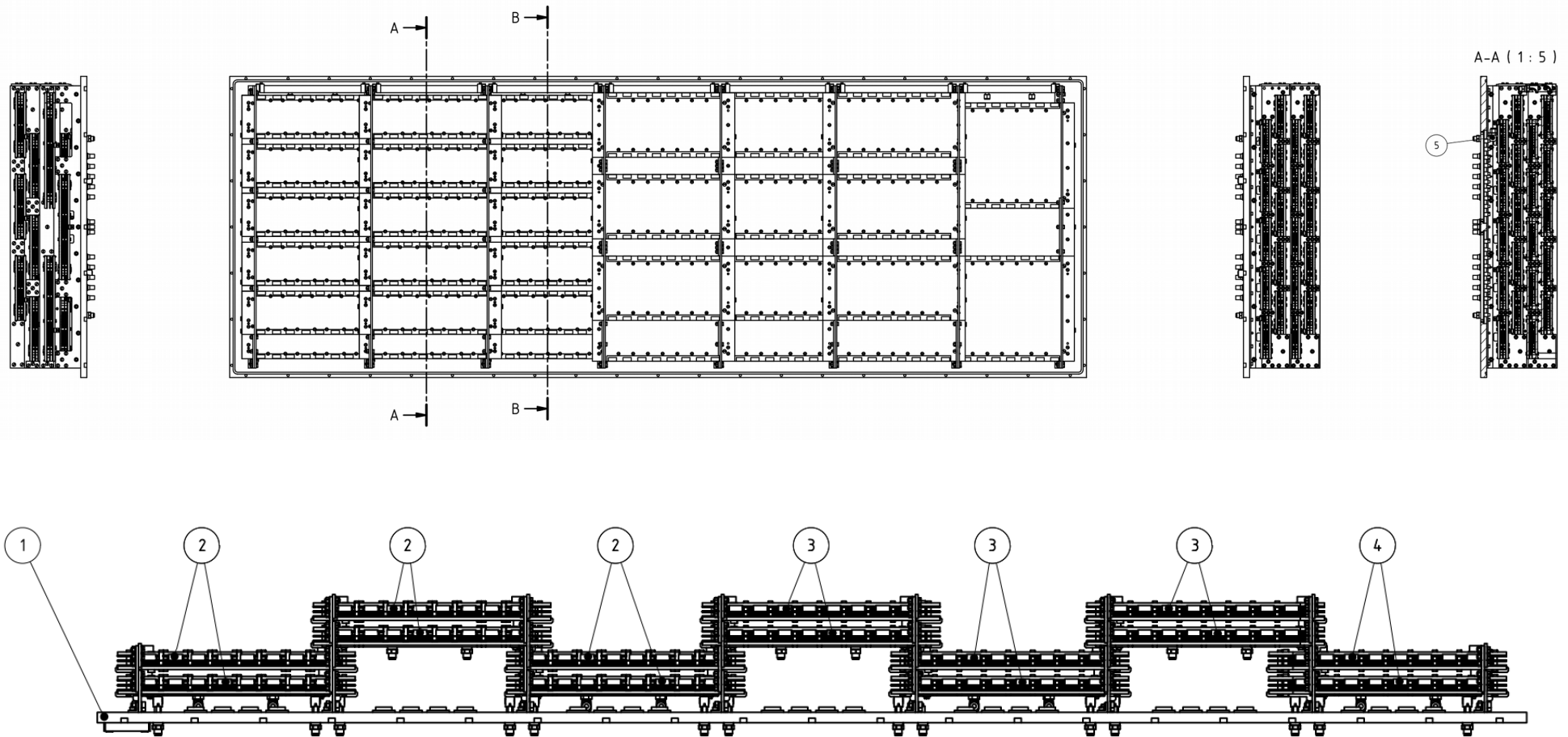
Back panel connectors:

- 408 inside
- 408 outside

weight: ~ 150kg

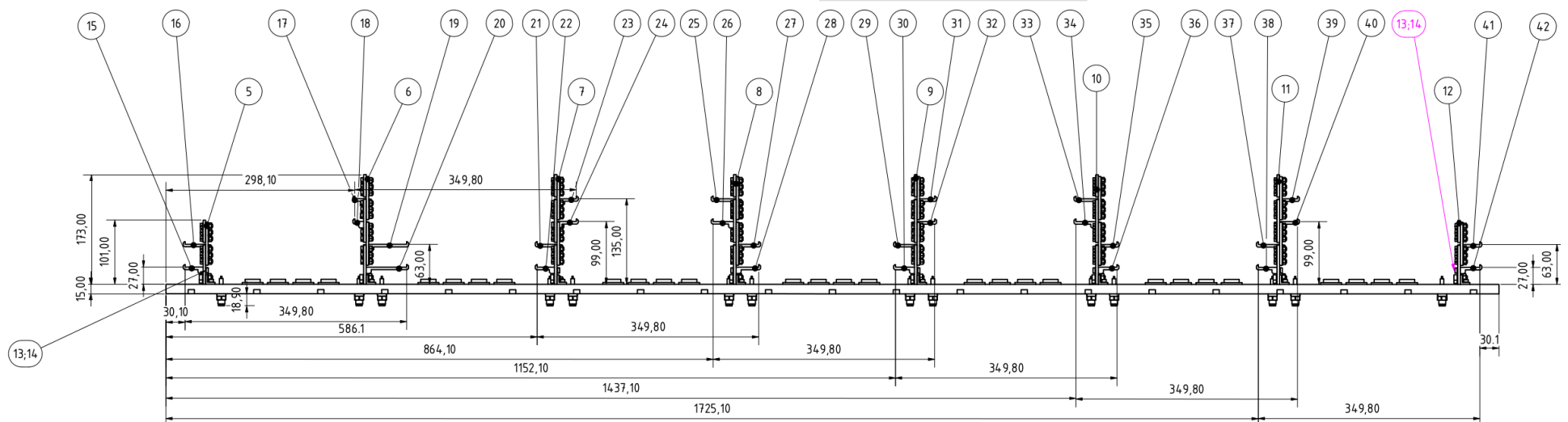
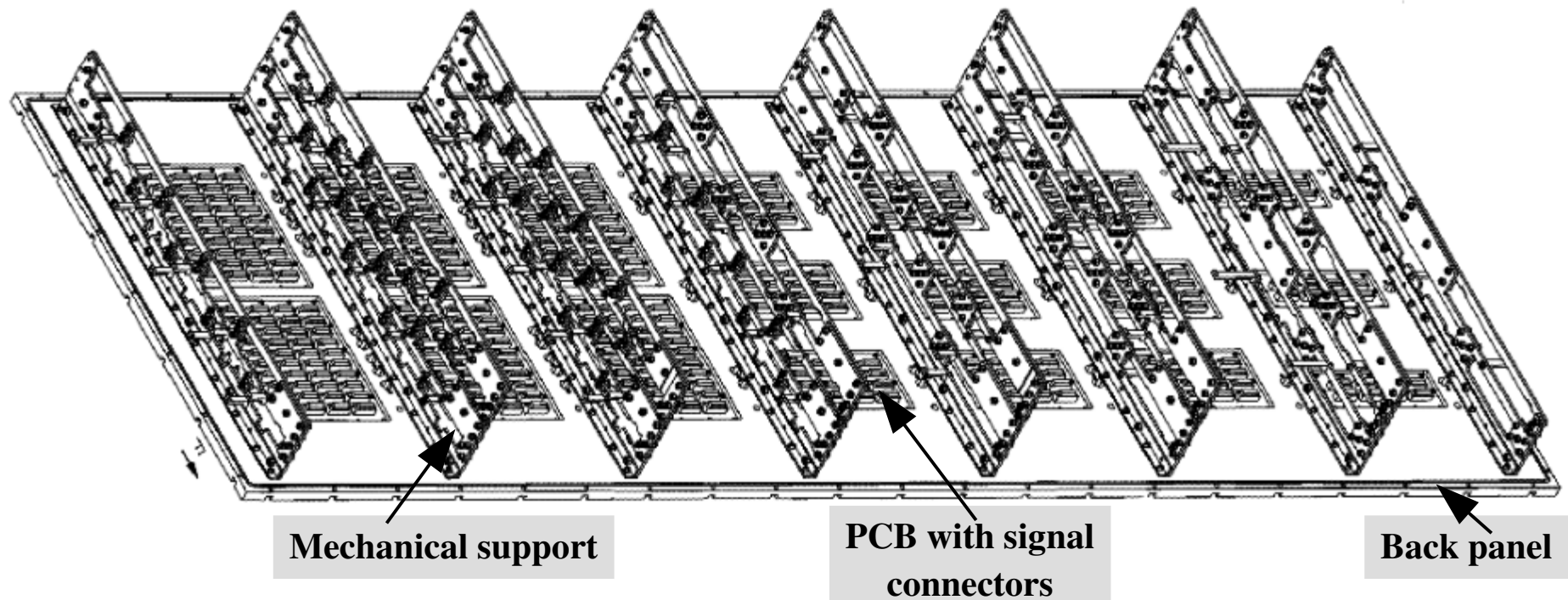


Modul M1 – details of the execution drawings

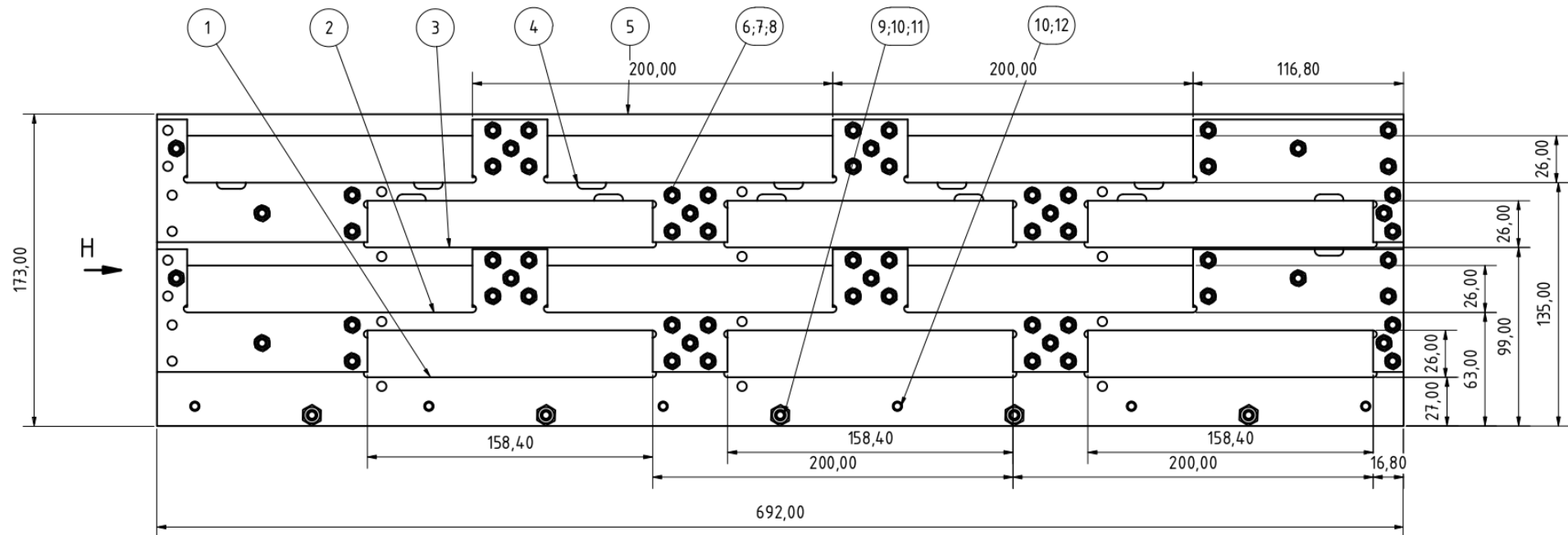


**MSMGRPCs are staggered on four layers
in order to provide the necessary overlap
for a continuous active area.**

Modul M1 – details of the execution drawings → mechanical supports



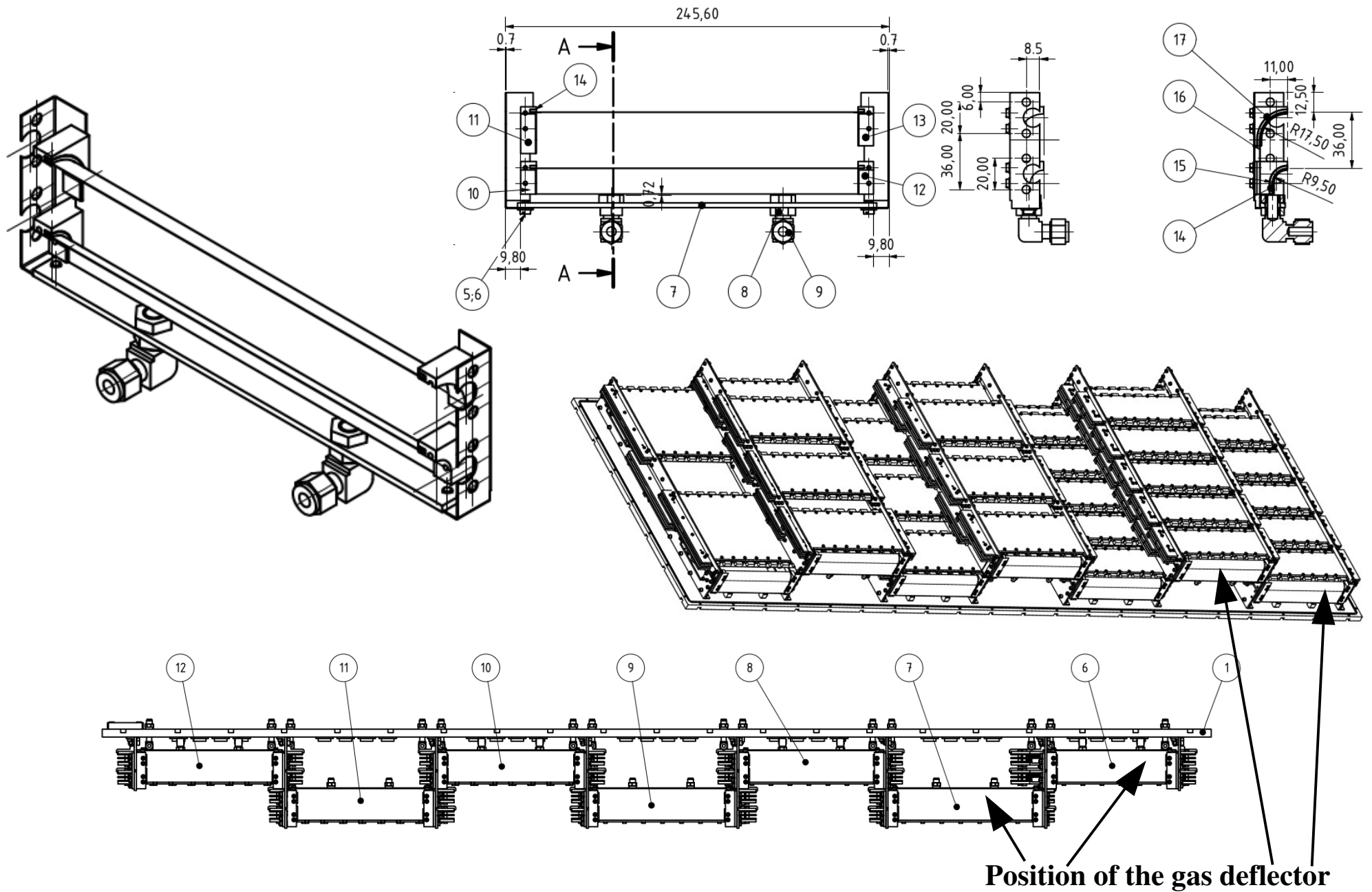
Modul M1 – details of the execution drawings for a mechanical support



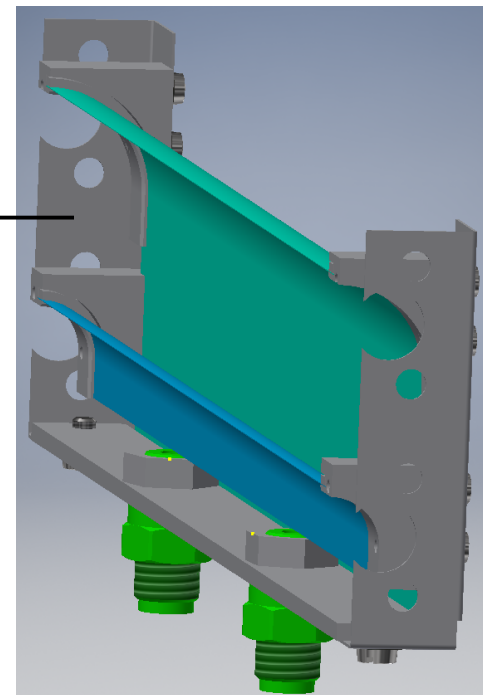
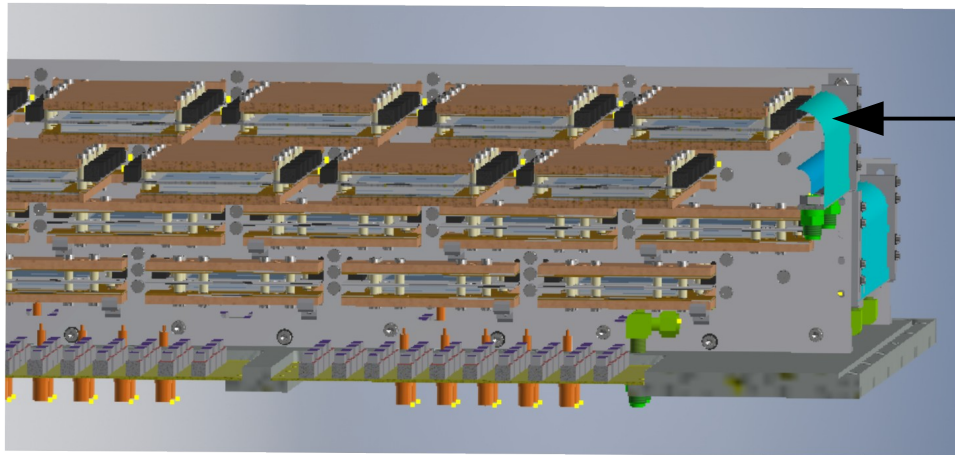
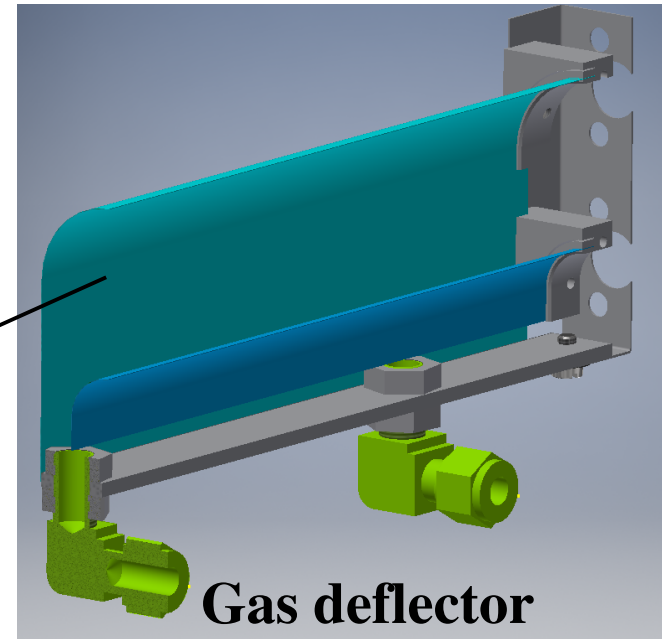
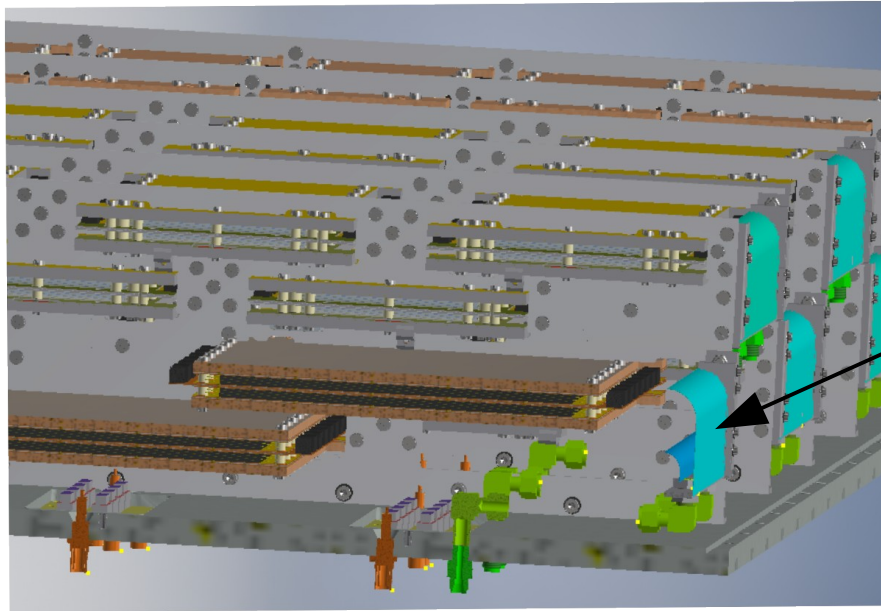
H (1 : 2



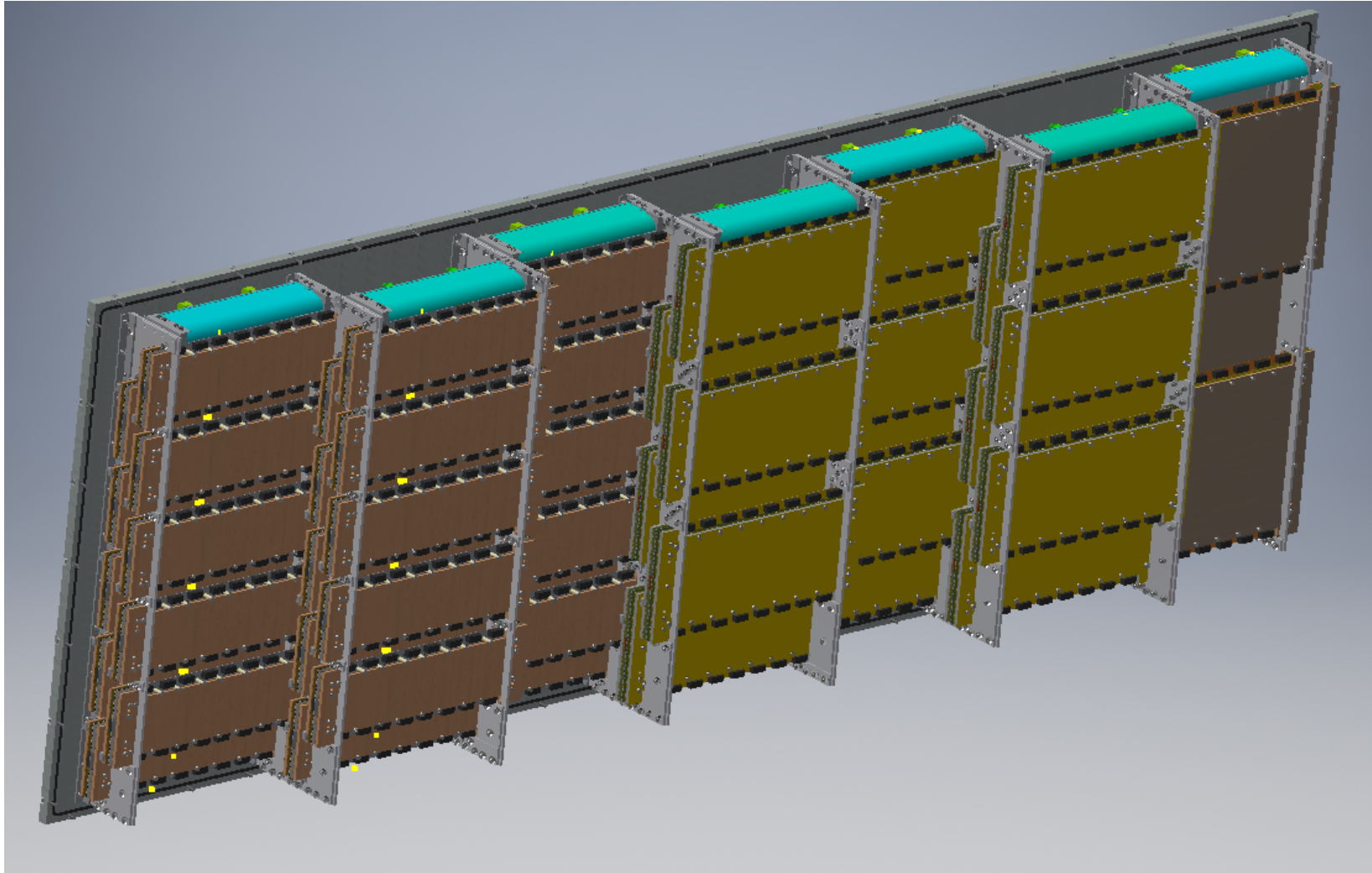
M1 design details – gas deflector



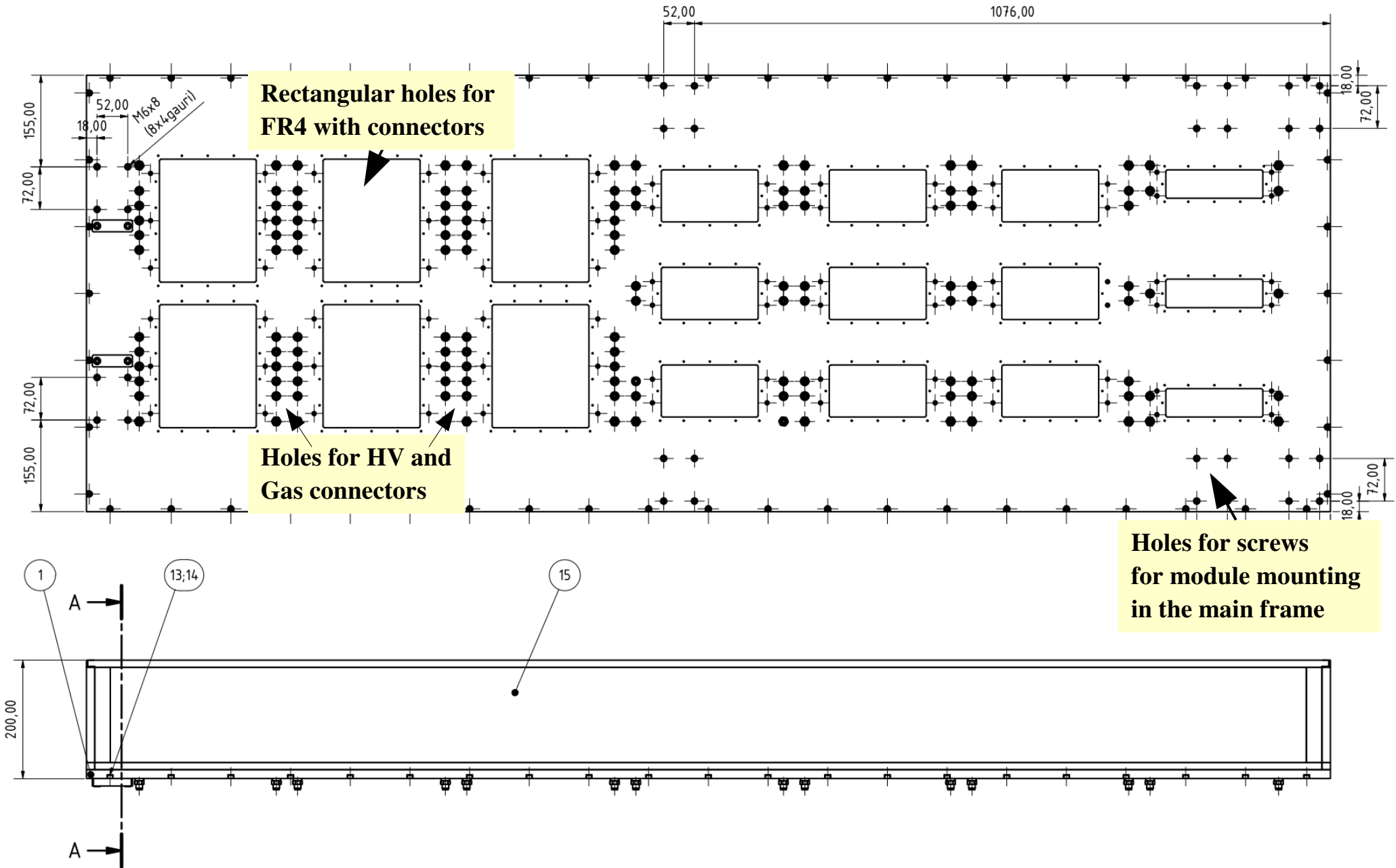
M1 design details – gas deflector 3D view



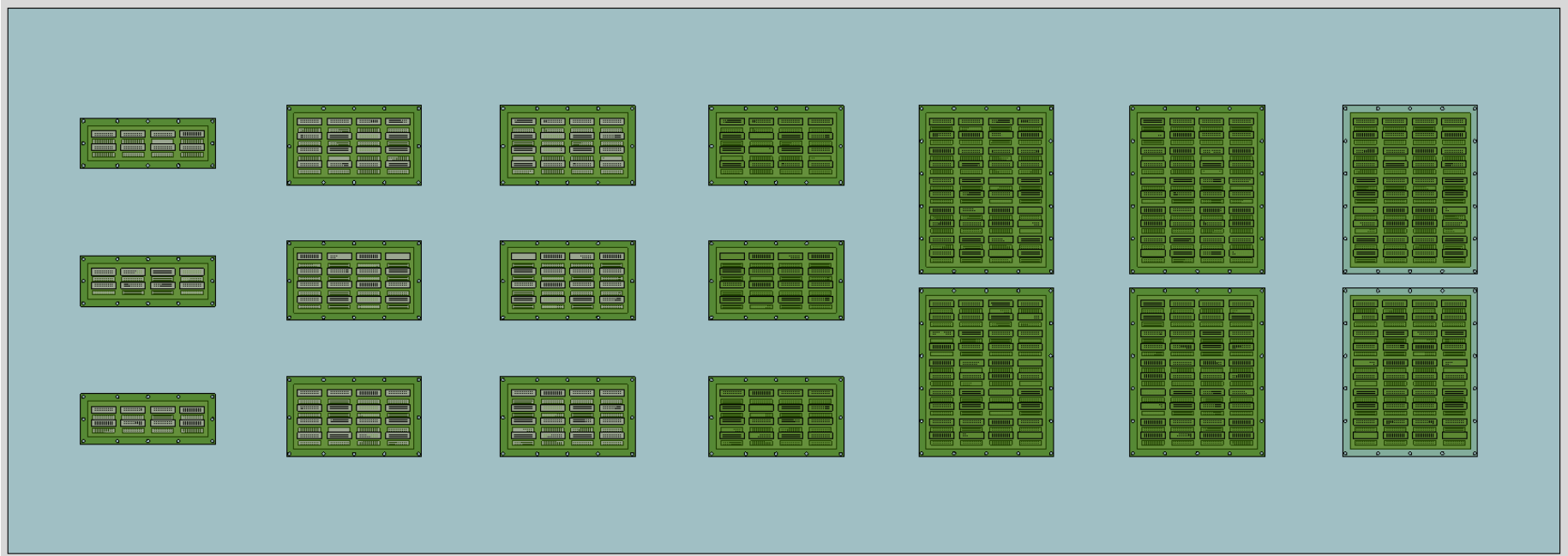
M1 equipped with gas deflectors



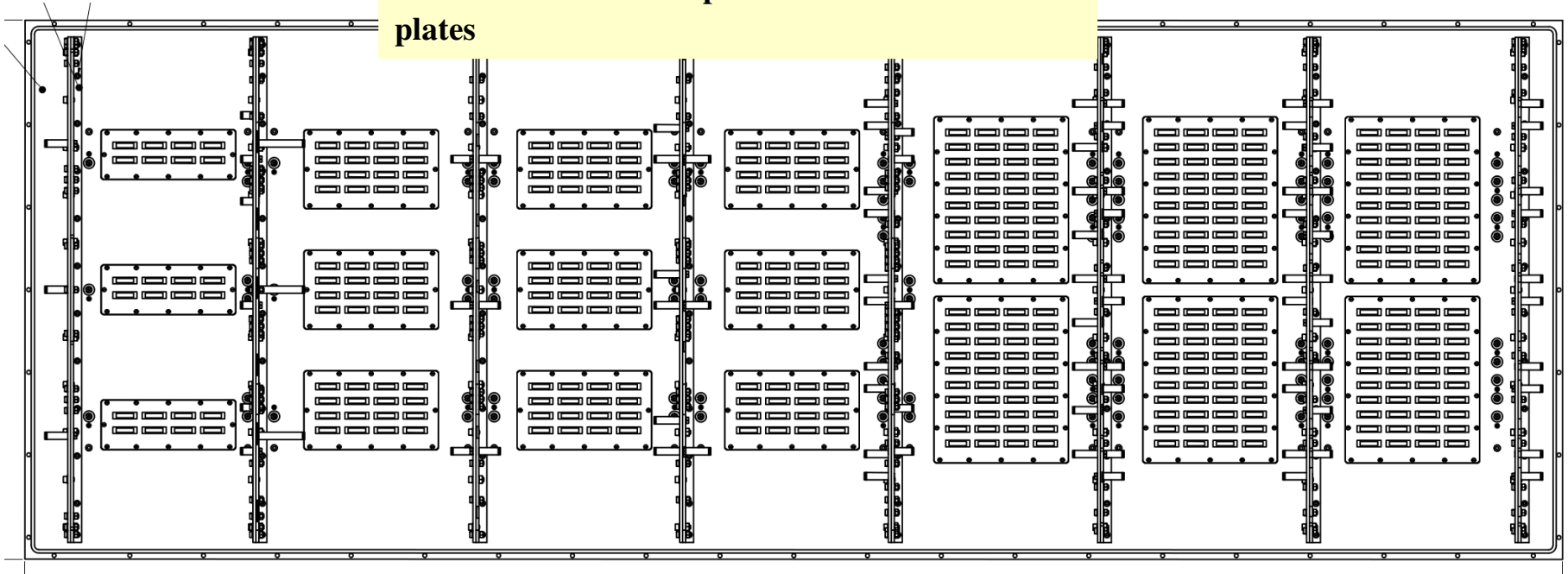
M1 design details – Al backpanel



M1 design details – AI backpanel

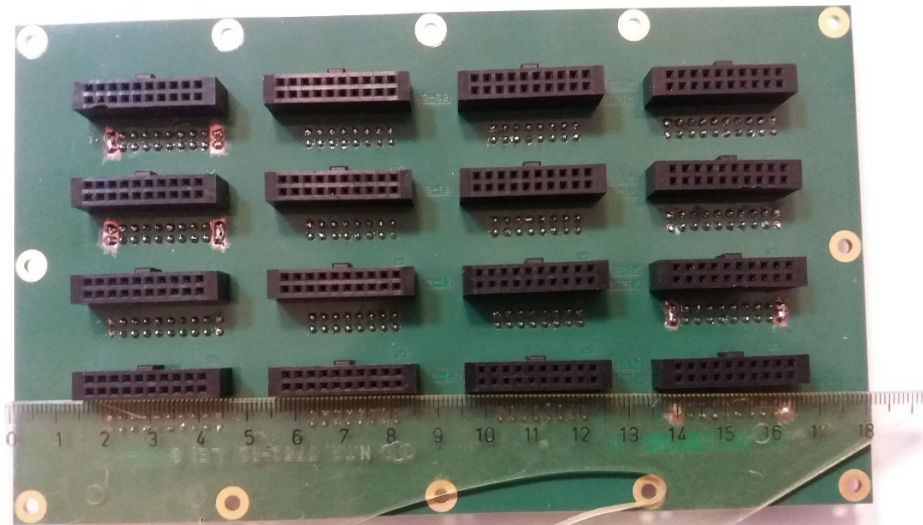
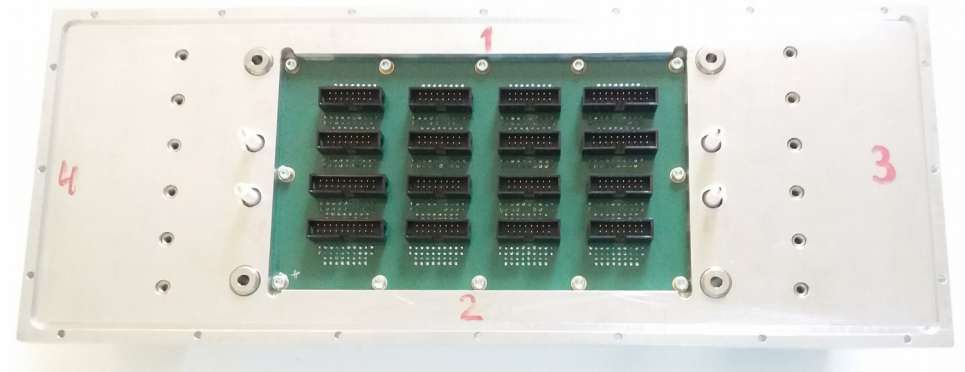
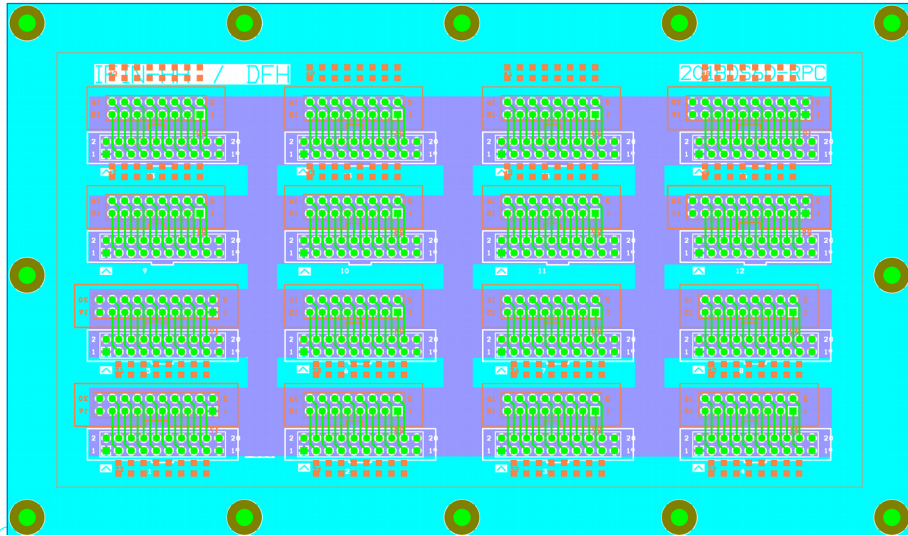


Inner side of the back panel with connector plates

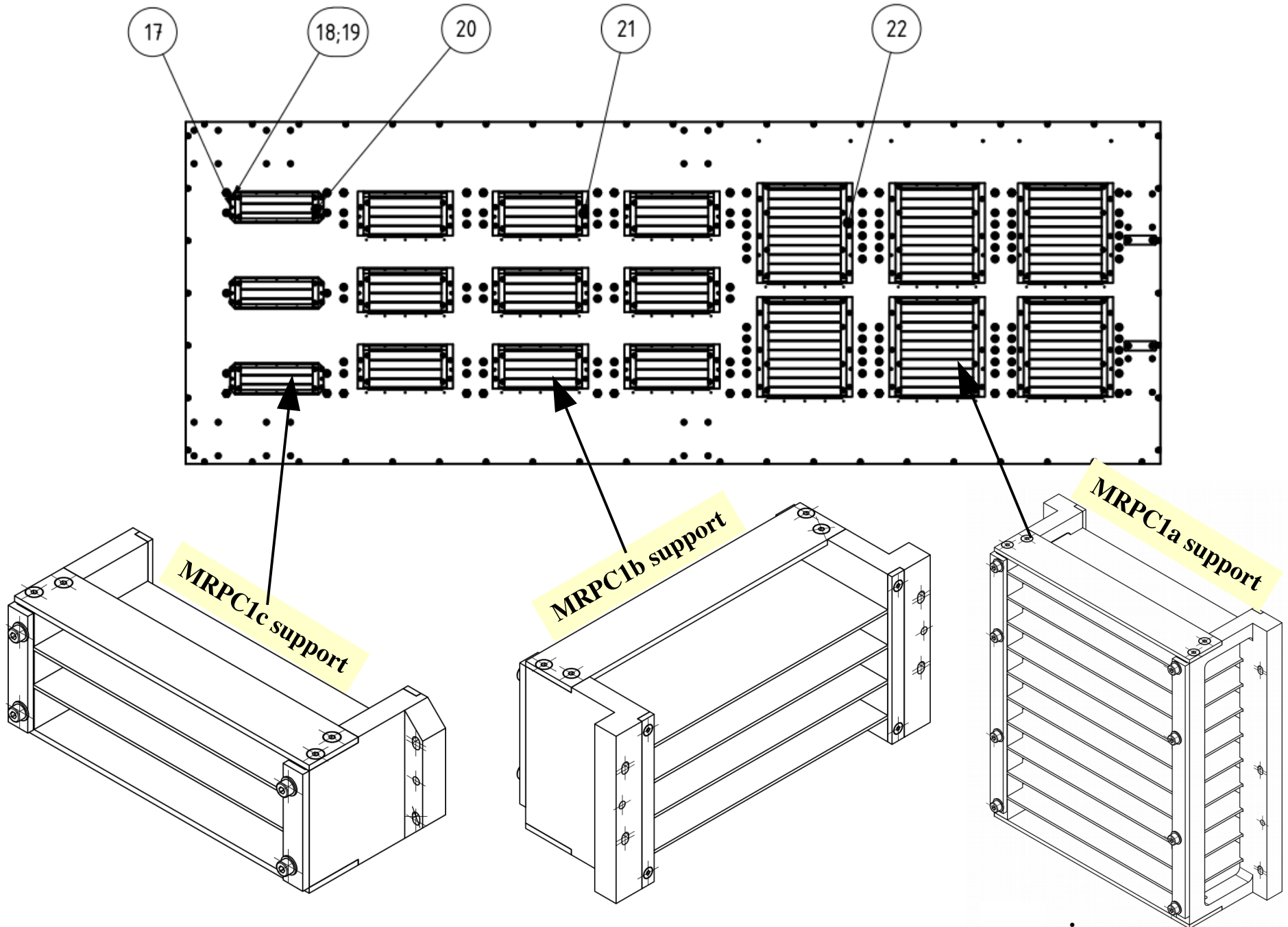


Back pannel connector plate

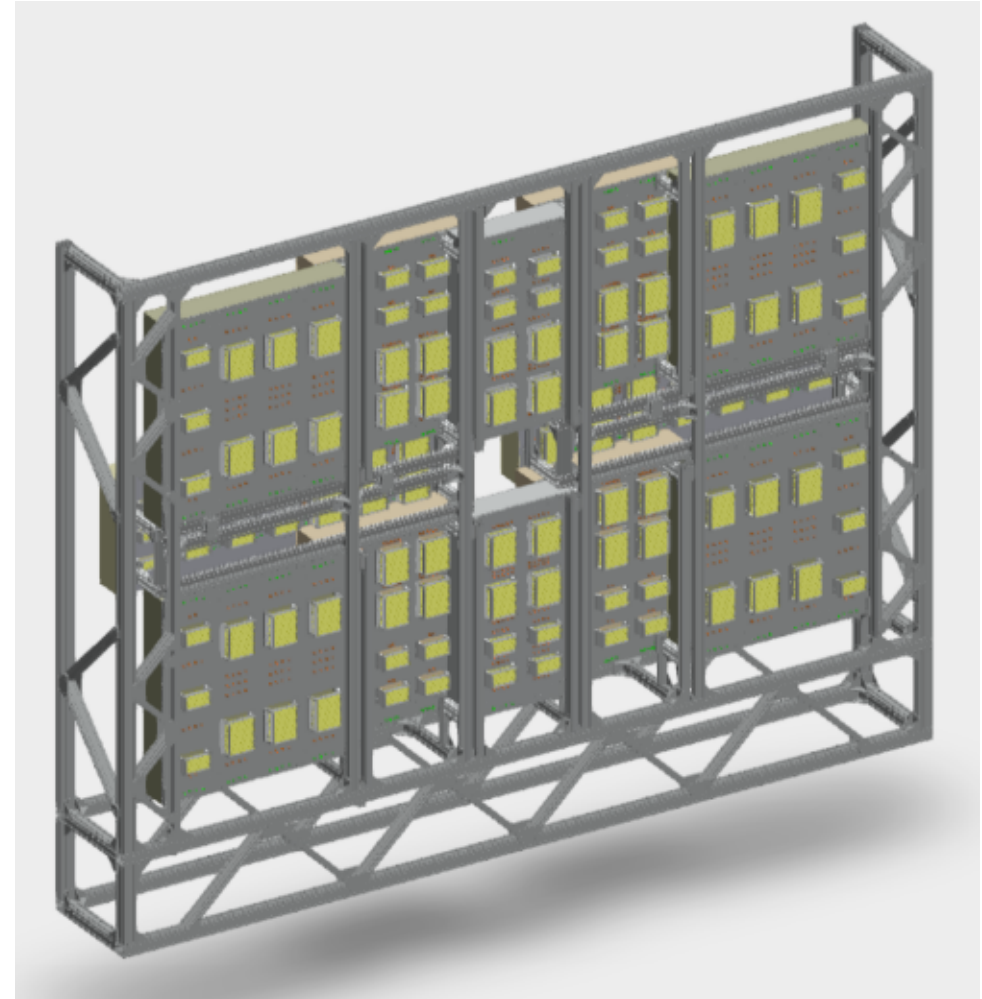
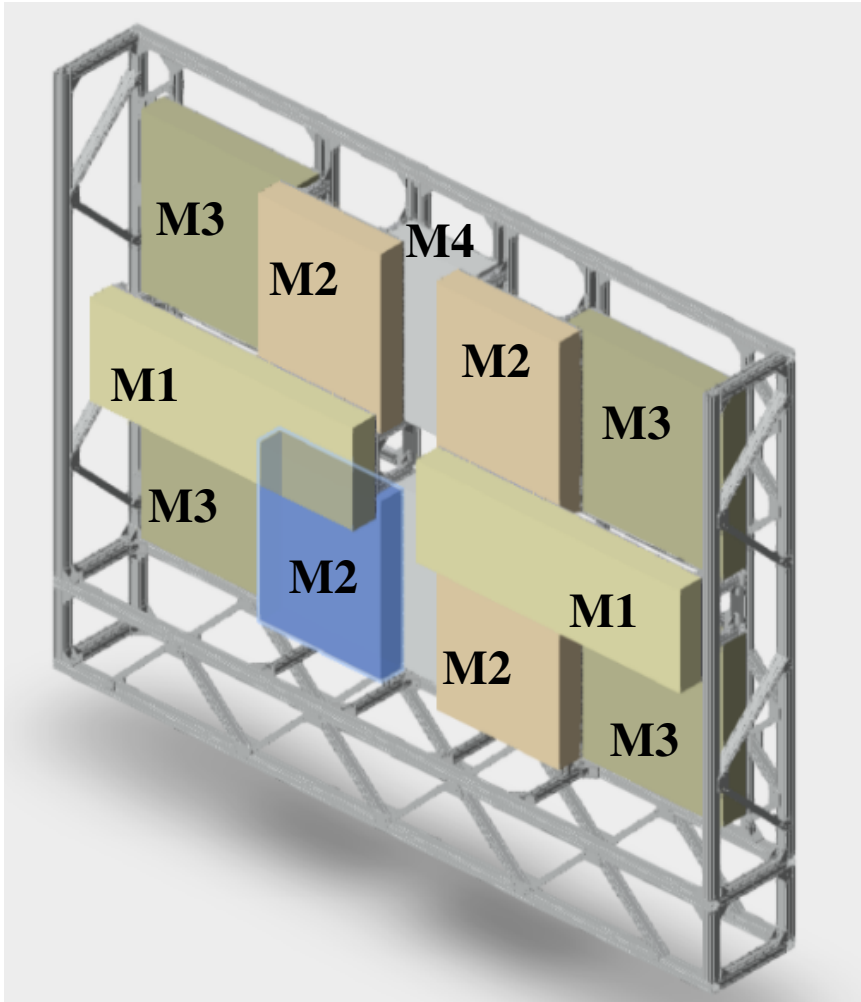
OrCAD



M1 design details – FEE mechanical supports



Space frame design



Conclusions and Outlook

- **The MSMGRPC prototype with the highest granularity of the CBM-TOF wall was designed with 100 Ohm characteristic impedance of the transmission line matched to the input of the front-end electronics, using OrCAD and APLAC software.**
- **Two identical prototypes with the highest granularity of the CBM-TOF wall were assembled based on this design.**
- **A modular design of the inner zone of the CBM-TOF wall, cover the active area with 12 modules of 4 types. The modules are populated with up to three types of MSMGRPCs which differ only by their strip length, having the same inner geometry.**
- **Detailed technical drawings for the design of M1 module have been performed.**
- **Module M1 is going to be assembled in the near future.**

Conclusions and Outlook

The presented activity was reported in:

✓ **M. Petris et al.**

“Status of the activities for the CBM-TOF inner wall”

34th CBM Collaboration Meeting, 29th September - 3rd October 2019, Kolkata, India

✓ **M. Petris et al.**

“Towards the construction of the CBM-TOF inner zone”

**XXIII International School on Nuclear Physics, Neutron and Applications,
September 22 – 28, 2019 Varna, Bulgaria**



Thank you for your attention!